

# EFM32PG22 Gecko MCU Family Data Sheet



The EFM32PG22 Gecko family of microcontrollers is part of the Series 2 Gecko portfolio. EFM32PG22 Gecko MCUs are ideal for enabling energy-friendly embedded applications.

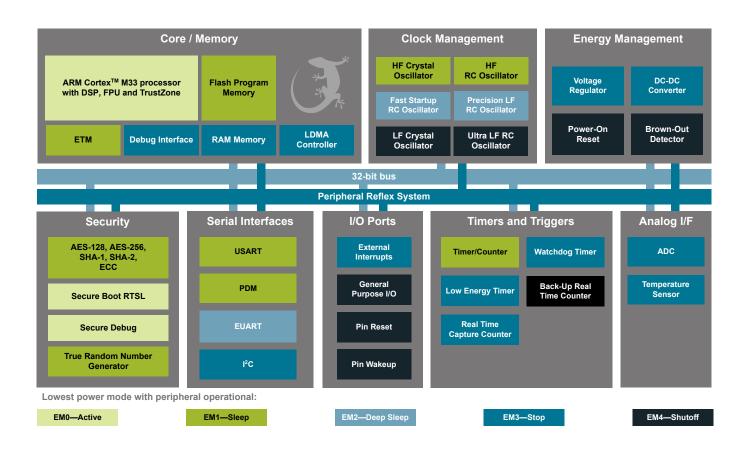
The highly efficient solution contains a 76.8 MHz Cortex-M33 with rich analog and communication peripherals to provide an industry-leading, energy efficient MCU for consumer and industrial applications.

Gecko applications include:

- · Personal Hygiene devices
- Appliances and whitegoods
- Industrial Automation
- · Consumer electronics

#### KEY FEATURES

- 32-bit ARM® Cortex®-M33 core with 76.8 MHz maximum operating frequency
- Up to 512 kB of flash and 32 kB of RAM
- · Low energy operation
- 26 uA/MHz (EM0)
- 1.10 uA sleep (EM2)
- Secure Boot with Root of Trust and Secure Loader (RTSL)
- · 16-bit ADC with 16-channel scan



### 1. Feature List

The EFM32PG22 highlighted features are listed below.

#### Low Power MCU

- High Performance 32-bit 76.8 MHz ARM Cortex<sup>®</sup>-M33 with DSP instruction and floating-point unit for efficient signal processing
- Up to 512 kB flash program memory
- Up to 32 kB RAM data memory
- Low System Energy Consumption
  - 26 µA/MHz in Active Mode (EM0) at 38.4 MHz
  - 1.10 µA EM2 DeepSleep current (8 kB RAM retention and RTC running from LFRCO)
  - 0.95 µA EM3 DeepSleep current (8 kB RAM retention and RTC running from ULFRCO)
  - 0.17 µA EM4 current

#### Security Features

- Secure Boot with Root of Trust and Secure Loader (RTSL)
- Hardware Cryptographic Acceleration for AES128/256, SHA-1, SHA-2 (up to 256-bit), ECC (up to 256-bit), ECDSA, and ECDH
- True Random Number Generator (TRNG) compliant with NIST SP800-90 and AIS-31
- ARM<sup>®</sup> TrustZone<sup>®</sup>
- Secure Debug with lock/unlock

#### Packages

- **QFN40** 5 mm × 5 mm × 0.85 mm
- **QFN32** 4 mm × 4 mm × 0.85 mm

#### Wide selection of MCU peripherals

- Analog to Digital Converter (ADC)
  - 12-bit @ 1 Msps
  - 16-bit @ 76.9 ksps
- Up to 26 General Purpose I/O pins with output state retention and asynchronous interrupts
- 8 Channel DMA Controller
- 12 Channel Peripheral Reflex System (PRS)
- 4 × 16-bit Timer/Counter with 3 Compare/Capture/PWM channels
- 1 × 32-bit Timer/Counter with 3 Compare/Capture/PWM channels
- 32-bit Real Time Counter
- 24-bit Low Energy Timer for waveform generation
- 1 × Watchdog Timer
- 2 × Universal Synchronous/Asynchronous Receiver/Transmitter (UART/SPI/SmartCard (ISO 7816)/IrDA/I<sup>2</sup>S)
- 1 × Enhanced Universal Asynchronous Receiver/Transmitter (EUART)
- \*  $2 \times I^2C$  interface with SMBus support
- Digital microphone interface (PDM)
- Die temperature sensor with +/-1.5 °C accuracy after singlepoint calibration

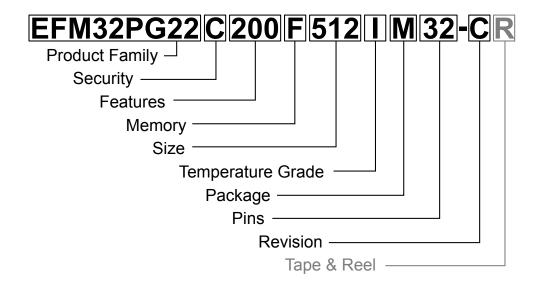
#### Wide Operating Range

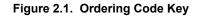
- 1.71 V to 3.8 V single power supply
- -40 °C to 125 °C

#### 2. Ordering Information

| Ordering Code           | Max CPU Speed | Flash<br>(kB) | RAM<br>(kB) | GPIO | Package | Temp Range    |
|-------------------------|---------------|---------------|-------------|------|---------|---------------|
| EFM32PG22C200F64IM40-C  | 76.8 MHz      | 64            | 32          | 26   | QFN40   | -40 to 125 °C |
| EFM32PG22C200F64IM32-C  | 76.8 MHz      | 64            | 32          | 18   | QFN32   | -40 to 125 °C |
| EFM32PG22C200F512IM40-C | 76.8 MHz      | 512           | 32          | 26   | QFN40   | -40 to 125 °C |
| EFM32PG22C200F512IM32-C | 76.8 MHz      | 512           | 32          | 18   | QFN32   | -40 to 125 °C |
| EFM32PG22C200F256IM40-C | 76.8 MHz      | 256           | 32          | 26   | QFN40   | -40 to 125 °C |
| EFM32PG22C200F256IM32-C | 76.8 MHz      | 256           | 32          | 18   | QFN32   | -40 to 125 °C |
| EFM32PG22C200F128IM40-C | 76.8 MHz      | 128           | 32          | 26   | QFN40   | -40 to 125 °C |
| EFM32PG22C200F128IM32-C | 76.8 MHz      | 128           | 32          | 18   | QFN32   | -40 to 125 °C |

#### Table 2.1. Ordering Information





| Field                 | Options                                                                                                                    |
|-----------------------|----------------------------------------------------------------------------------------------------------------------------|
| Product Family        | EFM32PG22: Gecko 23 Family                                                                                                 |
| Security              | C: Secure Boot with RTSL                                                                                                   |
| Features [f1][f2][f3] | <ul> <li>f1</li> <li>2: MCU Frequency of 76.8 MHz</li> <li>f2</li> <li>0: Unused</li> <li>f3</li> <li>0: Unused</li> </ul> |
| Memory                | • F: Flash                                                                                                                 |
| Size                  | Memory Size in kBytes                                                                                                      |
| Temperature Grade     | <ul> <li>G: -40 to +85 °C</li> <li>I: -40 to +125 °C</li> </ul>                                                            |
| Package               | • <b>M</b> : QFN                                                                                                           |
| Pins                  | Number of Package Pins                                                                                                     |
| Revision              | C: Revision C                                                                                                              |
| Tape & Reel           | • <b>R</b> : Tape & Reel (optional)                                                                                        |

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#### 3. System Overview

#### 3.1 Introduction

The EFM32PG22 Gecko product family is well suited for any battery operated application as well as other systems requiring high performance and low energy consumption. This section gives a short introduction to the MCU system. The detailed functional description can be found in the EFM32PG22 Reference Manual.

A block diagram of the EFM32PG22 family is shown in Figure 3.1 Detailed EFM32PG22 Block Diagram on page 8. The diagram shows a superset of features available on the family, which vary by OPN. For more information about specific device features, consult 2. Ordering Information.

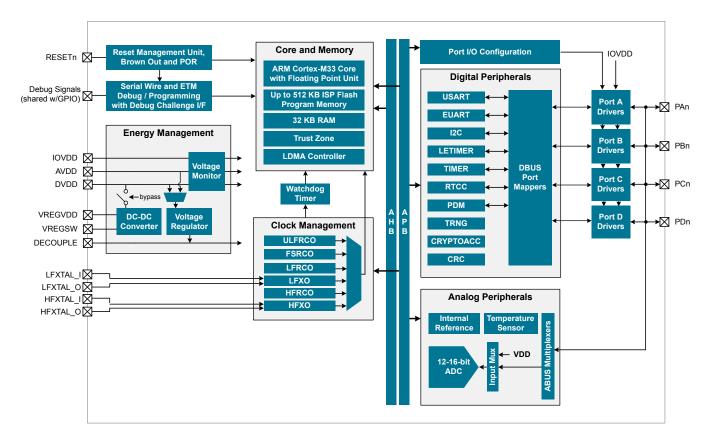


Figure 3.1. Detailed EFM32PG22 Block Diagram

#### 3.2 General Purpose Input/Output (GPIO)

EFM32PG22 has up to 26 General Purpose Input/Output pins. Each GPIO pin can be individually configured as either an output or input. More advanced configurations including open-drain, open-source, and glitch-filtering can be configured for each individual GPIO pin. The GPIO pins can be overridden by peripheral connections, like SPI communication. Each peripheral connection can be routed to several GPIO pins on the device. The input value of a GPIO pin can be routed through the Peripheral Reflex System to other peripherals. The GPIO subsystem supports asynchronous external pin interrupts.

All of the pins on ports A and port B are EM2 capable. These pins may be used by Low-Energy peripherals in EM2/3 and may also be used as EM2/3 pin wake-ups. Pins on ports C and D are latched/retained in their current state when entering EM2 until EM2 exit upon which internal peripherals could once again drive those pads.

A few GPIOs also have EM4 wake functionality. These pins are listed in the Alternate Function Table.

#### 3.3 Clocking

#### 3.3.1 Clock Management Unit (CMU)

The Clock Management Unit controls oscillators and clocks in the EFM32PG22. Individual enabling and disabling of clocks to all peripheral modules is performed by the CMU. The CMU also controls enabling and configuration of the oscillators. A high degree of flexibility allows software to optimize energy consumption in any specific application by minimizing power dissipation in unused peripherals and oscillators.

#### 3.3.2 Internal and External Oscillators

The EFM32PG22 supports two crystal oscillators and fully integrates four RC oscillators, listed below.

- A high frequency crystal oscillator (HFXO) with integrated load capacitors, tunable in small steps, provides a precise timing reference for the MCU. The HFXO can also support an external clock source such as a TCXO for applications that require an extremely accurate clock frequency over temperature.
- A 32.768 kHz crystal oscillator (LFXO) provides an accurate timing reference for low energy modes.
- An integrated high frequency RC oscillator (HFRCO) is available for the MCU system, when crystal accuracy is not required. The HFRCO employs fast start-up at minimal energy consumption combined with a wide frequency range, from 1 MHz to 76.8 MHz.
- An integrated fast start-up RC oscillator (FSRCO) that runs at a fixed 20 MHz
- An integrated low frequency 32.768 kHz RC oscillator (LFRCO) for low power operation without an external crystal. Precision mode enables periodic recalibration against the 38.4 MHz HFXO crystal to improve accuracy to +/- 500 ppm.
- An integrated ultra-low frequency 1 kHz RC oscillator (ULFRCO) is available to provide a timing reference at the lowest energy consumption in low energy modes.

#### 3.4 Counters/Timers and PWM

#### 3.4.1 Timer/Counter (TIMER)

TIMER peripherals keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the Peripheral Reflex System (PRS). The core of each TIMER is a 16-bit or 32-bit counter with up to 3 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the TIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers. In addition some timers offer dead-time insertion.

See 3.12 Configuration Summary for information on the feature set of each timer.

#### 3.4.2 Low Energy Timer (LETIMER)

The unique LETIMER is a 24-bit timer that is available in energy mode EM0 Active, EM1 Sleep, EM2 Deep Sleep, and EM3 Stop. This allows it to be used for timing and output generation when most of the device is powered down, allowing simple tasks to be performed while the power consumption of the system is kept at an absolute minimum. The LETIMER can be used to output a variety of waveforms with minimal software intervention. The LETIMER is connected to the Peripheral Reflex System (PRS), and can be configured to start counting on compare matches from other peripherals such as the Real Time Clock.

#### 3.4.3 Real Time Clock with Capture (RTCC)

The Real Time Clock with Capture (RTCC) is a 32-bit counter providing timekeeping down to EM3. The RTCC can be clocked by any of the on-board low-frequency oscillators, and it is capable of providing system wake-up at user defined intervals.

#### 3.4.4 Back-Up Real Time Counter (BURTC)

The Back-Up Real Time Counter (BURTC) is a 32-bit counter providing timekeeping in all energy modes, including EM4. The BURTC can be clocked by any of the on-board low-frequency oscillators, and it is capable of providing system wake-up at user-defined intervals.

#### 3.4.5 Watchdog Timer (WDOG)

The watchdog timer can act both as an independent watchdog or as a watchdog synchronous with the CPU clock. It has windowed monitoring capabilities, and can generate a reset or different interrupts depending on the failure mode of the system. The watchdog can also monitor autonomous systems driven by the Peripheral Reflex System (PRS).

#### 3.5 Communications and Other Digital Peripherals

#### 3.5.1 Universal Synchronous/Asynchronous Receiver/Transmitter (USART)

The Universal Synchronous/Asynchronous Receiver/Transmitter is a flexible serial I/O module. It supports full duplex asynchronous UART communication with hardware flow control as well as RS-485, SPI, MicroWire and 3-wire. It can also interface with devices supporting:

- ISO7816 SmartCards
- IrDA
- I<sup>2</sup>S

#### 3.5.2 Enhanced Universal Asynchronous Receiver/Transmitter (EUART)

The Enhanced Universal Asynchronous Receiver/Transmitter supports full duplex asynchronous UART communication with hardware flow control, RS-485 and IrDA support. In EM0 and EM1 the EUART provides a high-speed, buffered communication interface.

When routed to GPIO ports A or B, the EUART may also be used in a low-energy mode and operate in EM2. A 32.768 kHz clock source allows full duplex UART communication up to 9600 baud.

#### 3.5.3 Inter-Integrated Circuit Interface (I<sup>2</sup>C)

The I<sup>2</sup>C module provides an interface between the MCU and a serial I<sup>2</sup>C bus. It is capable of acting as a main or secondary interface and supports multi-drop buses. Standard-mode, fast-mode and fast-mode plus speeds are supported, allowing transmission rates from 10 kbit/s up to 1 Mbit/s. Bus arbitration and timeouts are also available, allowing implementation of an SMBus-compliant system. The interface provided to software by the I<sup>2</sup>C module allows precise timing control of the transmission process and highly automated transfers. Automatic recognition of addresses is provided in active and low energy modes. Note that not all instances of I<sup>2</sup>C are available in all energy modes.

#### 3.5.4 Peripheral Reflex System (PRS)

The Peripheral Reflex System provides a communication network between different peripheral modules without software involvement. Peripheral modules producing Reflex signals are called producers. The PRS routes Reflex signals from producers to consumer peripherals which in turn perform actions in response. Edge triggers and other functionality such as simple logic operations (AND, OR, NOT) can be applied by the PRS to the signals. The PRS allows peripherals to act autonomously without waking the MCU core, saving power.

#### 3.5.5 Pulse Density Modulation (PDM) Interface

The PDM module provides a serial interface and decimation filter for Pulse Density Modulation (PDM) microphones, isolated Sigmadelta ADCs, digital sensors and other PDM or sigma delta bit stream peripherals. A programmable Cascaded Integrator Comb (CIC) filter is used to decimate the incoming bit streams. PDM supports stereo or mono input data and DMA transfer.

#### 3.6 Security Features

The following security features are available on the EFM32PG22:

- · Secure Boot with Root of Trust and Secure Loader (RTSL)
- Cryptographic Accelerator
- True Random Number Generator (TRNG)
- Secure Debug with Lock/Unlock

#### 3.6.1 Secure Boot with Root of Trust and Secure Loader (RTSL)

The Secure Boot with RTSL authenticates a chain of trusted firmware that begins from an immutable memory (ROM).

It prevents malware injection, prevents rollback, ensures that only authentic firmware is executed.

More information on this feature can be found in the Application Note AN1218: Series 2 Secure Boot with RTSL.

#### 3.6.2 Cryptographic Accelerator

The Cryptographic Accelerator is an autonomous hardware accelerator which supports AES encryption and decryption with 128/192/256-bit keys, Elliptic Curve Cryptography (ECC) to support public key operations and hashes.

Supported block cipher modes of operation for AES include:

- ECB (Electronic Code Book)
- CTR (Counter Mode)
- CBC (Cipher Block Chaining)
- CFB (Cipher Feedback)
- GCM (Galois Counter Mode)
- CBC-MAC (Cipher Block Chaining Message Authentication Code)
- · GMAC (Galois Message Authentication Code)
- CCM (Counter with CBC-MAC)

The Cryptographic Accelerator accelerates Elliptical Curve Cryptography and supports the NIST (National Institute of Standards and Technology) recommended curves including P-192 and P-256 for ECDH(Elliptic Curve Diffie-Hellman) key derivation and ECDSA (Elliptic Curve Digital Signature Algorithm) sign and verify operations.

Supported hashes include SHA-1, SHA2/224, and SHA-2/256.

This implementation provides a fast and energy efficient solution to state of the art cryptographic needs.

#### 3.6.3 True Random Number Generator

The True Random Number Generator module is a non-deterministic random number generator that harvests entropy from a thermal energy source. It includes start-up health tests for the entropy source as required by NIST SP800-90B and AIS-31 as well as online health tests required for NIST SP800-90C.

The TRNG is suitable for periodically generating entropy to seed an approved pseudo random number generator.

#### 3.6.4 Secure Debug with Lock/Unlock

For obvious security reasons, it is critical for a product to have its debug interface locked before being released in the field.

In addition, the EFM32PG22 also provides a secure debug unlock function that allows authenticated access based on public key cryptography. This functionality is particularly useful for supporting failure analysis while maintaining confidentiality of IP and sensitive enduser data.

More information on this feature can be found in the Application Note AN1190.

#### 3.7 Analog

#### 3.7.1 Analog to Digital Converter (IADC)

The IADC is a hybrid architecture combining techniques from both SAR and Delta-Sigma style converters. It has a resolution of 12 bits at 1 Msps and 16 bits at up to 76.9 ksps. Hardware oversampling reduces system-level noise over multiple front-end samples. The IADC includes integrated voltage reference options. Inputs are selectable from a wide range of sources, including pins configurable as either single-ended or differential.

#### 3.8 Power

The EFM32PG22 has an Energy Management Unit (EMU) and efficient integrated regulators to generate internal supply voltages. Only a single external supply voltage is required, from which all internal voltages are created. An optional integrated DC-DC buck regulator can be utilized to further reduce the current consumption. The DC-DC regulator requires one external inductor and one external capacitor.

The EFM32PG22 device family includes support for internal supply voltage scaling, as well as two different power domains groups for peripherals. These enhancements allow for further supply current reductions and lower overall power consumption.

#### 3.8.1 Energy Management Unit (EMU)

The Energy Management Unit manages transitions of energy modes in the device. Each energy mode defines which peripherals and features are available and the amount of current the device consumes. The EMU can also be used to implement system-wide voltage scaling and turn off the power to unused RAM blocks to optimize the energy consumption in the target application. The DC-DC regulator operation is tightly integrated with the EMU.

#### 3.8.2 Voltage Scaling

The EFM32PG22 supports supply voltage scaling for the LDO powering DECOUPLE, with independent selections for EM0 / EM1 and EM2 / EM3. Voltage scaling helps to optimize the energy efficiency of the system by operating at lower voltages when possible. The EM0 / EM1 voltage scaling level defaults to VSCALE2, which allows the core to operate in active mode at full speed. The intermediate level, VSCALE1, allows operation in EM0 and EM1 at up to 40 MHz. The lowest level, VSCALE0, can be used to conserve power further in EM2 and EM3. The EMU will automatically switch the target voltage scaling level when transitioning between energy modes.

#### 3.8.3 DC-DC Converter

The DC-DC buck converter covers a wide range of load currents, provides high efficiency in energy modes EM0, EM1, EM2 and EM3, and can supply up to 60 mA for device operation. An on-chip supply-monitor signals when the supply voltage is low to allow bypass of the regulator via programmable software interrupt. It employs soft switching at boot and DCDC regulating-to-bypass transitions to limit the max supply slew-rate and mitigate inrush current.

#### 3.8.4 Power Domains

The EFM32PG22 has three peripheral power domains for operation in EM2 and EM3, as well as the ability to selectively retain configurations for EM0/EM1 peripherals. A small set of peripherals always remain powered on in EM2 and EM3, including all peripherals which are available in EM4. If all of the peripherals in PD0B or PD0C are configured as unused, that power domain will be powered off in EM2 or EM3, reducing the overall current consumption of the device. Likewise, if the application can tolerate the setup time to re-configure used EM0/EM1 peripherals on wake, register retention for these peripherals can be disabled to further reduce the EM2 or EM3 current.

| Always available in EM2/EM3                          | Power Domain PD0B | Power Domain PD0C      |
|------------------------------------------------------|-------------------|------------------------|
| RTCC                                                 | LETIMER0          | LFRCO (Precision Mode) |
| LFRCO (Non-precision mode) <sup>1</sup>              | IADC0             |                        |
| LFXO <sup>1</sup>                                    | 12C0              |                        |
| BURTC <sup>1</sup>                                   | WDOG0             |                        |
| ULFRCO <sup>1</sup>                                  | EUART0            |                        |
| FSRCO                                                | PRS               |                        |
|                                                      | DEBUG             |                        |
| <b>Note:</b><br>1. Peripheral also available in EM4. |                   |                        |

#### 3.9 Reset Management Unit (RMU)

The RMU is responsible for handling reset of the EFM32PG22. A wide range of reset sources are available, including several power supply monitors, pin reset, software controlled reset, core lockup reset, and watchdog reset.

#### 3.10 Core and Memory

#### 3.10.1 Processor Core

The ARM Cortex-M processor includes a 32-bit RISC processor integrating the following features and tasks in the system:

- ARM Cortex-M33 RISC processor achieving 1.50 Dhrystone MIPS/MHz
- ARM TrustZone security technology
- · Embedded Trace Macrocell (ETM) for real-time trace and debug
- Up to 512 kB flash program memory
- Up to 32 kB RAM data memory
- · Configuration and event handling of all modules
- · 2-pin Serial-Wire debug interface

#### 3.10.2 Memory System Controller (MSC)

The Memory System Controller (MSC) is the program memory unit of the microcontroller. The flash memory is readable and writable from both the Cortex-M33 and LDMA. In addition to the main flash array where Program code is normally written the MSC also provides an Information block where additional information such as special user information or flash-lock bits are stored. There is also a readonly page in the information block containing system and device calibration data. Read and write operations are supported in energy modes EM0 Active and EM1 Sleep.

#### 3.10.3 Linked Direct Memory Access Controller (LDMA)

The Linked Direct Memory Access (LDMA) controller allows the system to perform memory operations independently of software. This reduces both energy consumption and software workload. The LDMA allows operations to be linked together and staged, enabling so-phisticated operations to be implemented.

#### 3.11 Memory Map

The EFM32PG22 memory map is shown in the figures below. RAM and flash sizes are for the largest memory configuration.

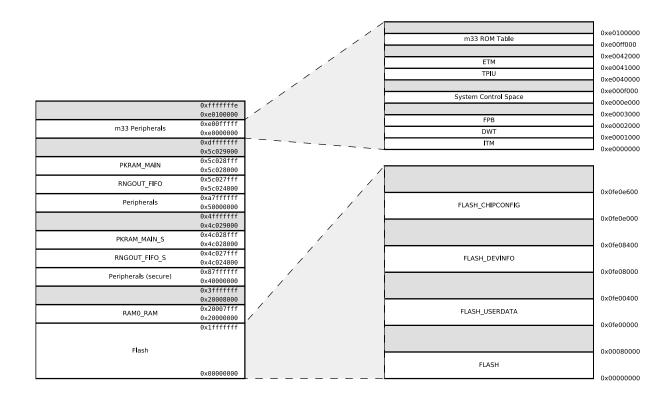


Figure 3.2. EFM32PG22 Memory Map — Core Peripherals and Code Space

#### 3.12 Configuration Summary

The features of the EFM32PG22 are a subset of the feature set described in the device reference manual. The table below describes device specific implementation of the features. Remaining modules support full configuration.

#### Table 3.2. Configuration Summary

| Module   | Lowest Energy Mode                                 | Configuration            |  |
|----------|----------------------------------------------------|--------------------------|--|
| I2C0     | EM3 <sup>1</sup>                                   |                          |  |
| I2C1     | EM1                                                |                          |  |
| IADC0    | EM3                                                |                          |  |
| LETIMER0 | EM2 <sup>1</sup>                                   |                          |  |
| PDM      | EM1                                                | 2-channel                |  |
| TIMER0   | EM1                                                | 32-bit, 3-channels, +DTI |  |
| TIMER1   | EM1                                                | 16-bit, 3-channels, +DTI |  |
| TIMER2   | EM1                                                | 16-bit, 3-channels, +DTI |  |
| TIMER3   | EM1                                                | 16-bit, 3-channels, +DTI |  |
| TIMER4   | EM1                                                | 16-bit, 3-channels, +DTI |  |
| EUART0   | EM1 - Full high-speed operation                    |                          |  |
|          | EM3 <sup>1</sup> - Low-energy operation, 9600 Baud |                          |  |
| USART0   | EM1                                                | +IrDA, +I2S, +SmartCard  |  |
| USART1   | EM1                                                | +IrDA, +I2S, +SmartCard  |  |

#### Note:

1. EM2 and EM3 operation is only supported for digital peripheral I/O on Port A and Port B. All GPIO ports support digital peripheral operation in EM0 and EM1.

#### 4. Electrical Specifications

#### 4.1 Electrical Characteristics

All electrical parameters in all tables are specified under the following conditions, unless stated otherwise:

- Typical values are based on T<sub>A</sub>=25 °C and all supplies at 3.0 V, by production test and/or technology characterization.
- Minimum and maximum values represent the worst conditions across supply voltage, process variation, and operating temperature, unless stated otherwise.

#### **Power Supply Pin Dependencies**

Due to on-chip circuitry (e.g., diodes), some EFM32 power supply pins have a dependent relationship with one or more other power supply pins. These internal relationships between the external voltages applied to the various EFM32 supply pins are defined below. Exceeding the below constraints can result in damage to the device and/or increased current draw.

- VREGVDD & DVDD
  - In systems using the DCDC converter, DVDD (the buck converter output) should be connected to the recommended L<sub>DCDC</sub> and C<sub>DCDC</sub>, and should not be driven by an off-chip regulator.
  - In systems not using the DCDC converter, DVDD must be shorted to VREGVDD on the PCB (VREGVDD=DVDD)
- DVDD ≥ DECOUPLE
- AVDD, IOVDD: No dependency with each other or any other supply pin. Additional leakage may occur if DVDD remains unpowered with power applied to these supplies.

#### 4.2 Absolute Maximum Ratings

Stresses beyond those listed below may cause permanent damage to the device. This is a stress rating only and functional operation of the devices at those or any other conditions beyond those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability. For more information on the available quality and reliability data, see the Quality and Reliability Monitor Report at http://www.silabs.com/support/quality/pages/default.aspx.

#### Table 4.1. Absolute Maximum Ratings

| Parameter                              | Symbol                 | Test Condition | Min  | Тур | Max                                                                                              | Unit   |
|----------------------------------------|------------------------|----------------|------|-----|--------------------------------------------------------------------------------------------------|--------|
| Storage temperature range              | T <sub>STG</sub>       |                | -50  | —   | +150                                                                                             | °C     |
| Voltage on any supply pin <sup>1</sup> | V <sub>DDMAX</sub>     |                | -0.3 | _   | 3.8                                                                                              | V      |
| Junction temperature                   | T <sub>JMAX</sub>      | -I grade       | _    | _   | +125                                                                                             | °C     |
| Voltage ramp rate on any supply pin    | V <sub>DDRAMPMAX</sub> |                | _    | _   | 1.0                                                                                              | V / µs |
| Voltage on HFXO pins                   | V <sub>HFXOPIN</sub>   |                | -0.3 | _   | 1.2                                                                                              | V      |
| DC voltage on any GPIO pin             | V <sub>DIGPIN</sub>    |                | -0.3 | _   | V <sub>IOVDD</sub> + 0.3                                                                         | V      |
| DC voltage on RESETn pin <sup>2</sup>  | V <sub>RESETn</sub>    |                | -0.3 | _   | 3.8                                                                                              | V      |
| Total current into VDD power lines     | I <sub>VDDMAX</sub>    | Source         | _    |     | 200                                                                                              | mA     |
| Total current into VSS ground lines    | I <sub>VSSMAX</sub>    | Sink           | _    |     | 200                                                                                              | mA     |
| Current per I/O pin                    | I <sub>IOMAX</sub>     | Sink           | _    |     | 50                                                                                               | mA     |
|                                        |                        | Source         | _    | _   | 50                                                                                               | mA     |
| Current for all I/O pins               | I <sub>IOALLMAX</sub>  | Sink           | —    | _   | 200                                                                                              | mA     |
|                                        |                        | Source         |      | _   | 3.8<br>+125<br>1.0<br>1.2<br>V <sub>IOVDD</sub> +<br>0.3<br>3.8<br>200<br>200<br>200<br>50<br>50 | mA     |

#### Note:

1. The maximum supply voltage on VREGVDD is limited under certain conditions when using the DC-DC. See the DC-DC specifications for more details.

2. The RESETn pin has a pull-up device to the DVDD supply. For minimum leakage, RESETn should not exceed the voltage at DVDD.

#### 4.3 General Operating Conditions

| Parameter                                        | Symbol                   | Test Condition                                                                             | Min  | Тур | Мах  | Unit |
|--------------------------------------------------|--------------------------|--------------------------------------------------------------------------------------------|------|-----|------|------|
| Operating ambient tempera-<br>ture range         | T <sub>A</sub>           | -I temperature grade <sup>1</sup>                                                          | -40  | -   | +125 | °C   |
| DVDD supply voltage                              | V <sub>DVDD</sub>        | EM0/1                                                                                      | 1.71 | 3.0 | 3.8  | V    |
|                                                  |                          | EM2/3/4 <sup>2</sup>                                                                       | 1.71 | 3.0 | 3.8  | V    |
| AVDD supply voltage                              | V <sub>AVDD</sub>        |                                                                                            | 1.71 | 3.0 | 3.8  | V    |
| IOVDDx operating supply voltage (All IOVDD pins) | V <sub>IOVDDx</sub>      |                                                                                            | 1.71 | 3.0 | 3.8  | V    |
| VREGVDD operating supply                         | V <sub>VREGVDD</sub>     | DC-DC in regulation <sup>3</sup>                                                           | 2.2  | 3.0 | 3.8  | V    |
| oltage                                           |                          | DC-DC in bypass 60 mA load                                                                 | 1.8  | 3.0 | 3.8  | V    |
|                                                  |                          | DC-DC not in use. DVDD exter-<br>nally shorted to VREGVDD                                  | 1.71 | 3.0 | 3.8  | V    |
| DECOUPLE output capaci-<br>tor <sup>4</sup>      | C <sub>DECOUPLE</sub>    | $1.0 \ \mu\text{F} \pm 10\% \ \text{X8L}$ capacitor used for performance characterization. | 1.0  | _   | 2.75 | μF   |
| HCLK and SYSCLK frequen-                         | f <sub>HCLK</sub>        | VSCALE2, MODE = WS1                                                                        | _    | _   | 76.8 | MHz  |
| су                                               |                          | VSCALE2, MODE = WS0                                                                        | _    | _   | 40   | MHz  |
| PCLK frequency                                   | f <sub>PCLK</sub>        | VSCALE2                                                                                    | _    | —   | 50   | MHz  |
|                                                  |                          | VSCALE1                                                                                    | —    | _   | 40   | MHz  |
| EM01 Group A clock fre-                          | f <sub>EM01GRPACLK</sub> | VSCALE2                                                                                    | _    | _   | 76.8 | MHz  |
| quency                                           |                          | VSCALE1                                                                                    | _    | _   | 40   | MHz  |
| EM01 Group B clock fre-                          | f <sub>EM01GRPBCLK</sub> | VSCALE2                                                                                    | _    | -   | 76.8 | MHz  |
| quency                                           |                          | VSCALE1                                                                                    | _    | -   | 40   | MHz  |
| External Clock Input                             | f <sub>CLKIN</sub>       | VSCALE2 or VSCALE1                                                                         | _    | -   | 40   | MHz  |
| DPLL Reference Clock                             | fdpllrefclk              | VSCALE2 or VSCALE1                                                                         | _    | _   | 40   | MHz  |

#### Table 4.2. General Operating Conditions

#### Note:

1. The device may operate continuously at the maximum allowable ambient  $T_A$  rating as long as the absolute maximum  $T_{JMAX}$  is not exceeded. For an application with significant power dissipation, the allowable  $T_A$  may be lower than the maximum  $T_A$  rating.  $T_A = T_{JMAX}$  - (THETA<sub>JA</sub> x PowerDissipation). Refer to the Absolute Maximum Ratings table and the Thermal Characteristics table for  $T_{JMAX}$  and THETA<sub>JA</sub>.

2. The DVDD supply is monitored by the DVDD BOD in EM0/1 and the LE DVDD BOD in EM2/3/4.

3. The maximum supply voltage on VREGVDD is limited under certain conditions when using the DC-DC. See the DC-DC specifications for more details.

4. Murata GCM21BL81C105KA58L used for performance characterization. Actual capacitor values can be significantly de-rated from their specified nominal value by the rated tolerance, as well as the application's AC voltage, DC bias, and temperature. The minimum capacitance counting all error sources should be no less than 0.6 μF.

#### 4.4 DC-DC Converter

Test conditions:  $L_{DCDC}$  = 2.2 µH (Samsung CIG22H2R2MNE),  $C_{DCDC}$  = 4.7 µF (Samsung CL10B475KQ8NQNC),  $V_{VREGVDD}$  = 3.0 V,  $V_{OUT}$  = 1.8 V, IPKVAL in EM0/1 modes is set to 150 mA, and in EM2/3 modes is set to 90 mA, unless otherwise indicated.

#### Table 4.3. DC-DC Converter

| Parameter                                          | Symbol               | Test Condition                                                                                             | Min               | Тур  | Max  | Unit  |
|----------------------------------------------------|----------------------|------------------------------------------------------------------------------------------------------------|-------------------|------|------|-------|
| Input voltage range at<br>VREGVDD pin <sup>1</sup> | V <sub>VREGVDD</sub> | DCDC in regulation, I <sub>LOAD</sub> = 60<br>mA, EM0/EM1 mode                                             | 2.2               | 3.0  | 3.8* | V     |
|                                                    |                      | DCDC in regulation, I <sub>LOAD</sub> = 5<br>mA, EM0/EM1 or EM2/EM3 mode                                   | 1.8               | 3.0  | 3.8* | V     |
|                                                    |                      | Bypass mode                                                                                                | 1.8               | 3.0  | 3.8  | V     |
| Regulated output voltage                           | V <sub>OUT</sub>     |                                                                                                            | —                 | 1.8  | _    | V     |
| Regulation DC accuracy                             | ACC <sub>DC</sub>    | V <sub>VREGVDD</sub> ≥ 2.2 V, Steady state in<br>EM0/EM1 mode or EM2/EM3<br>mode                           | -2.5              | _    | 3.3  | %     |
| Regulation total accuracy                          | ACC <sub>TOT</sub>   | With mode transitions between EM0/EM1 and EM2/EM3 modes                                                    | -5                | _    | 7    | %     |
| Steady-state output ripple                         | V <sub>R</sub>       | I <sub>LOAD</sub> = 20 mA in EM0/EM1 mode                                                                  | _                 | 14.3 | _    | mVpp  |
| DC line regulation                                 | V <sub>REG</sub>     | $I_{LOAD}$ = 60 mA in EM0/EM1<br>mode, $V_{VREGVDD} \ge 2.2 V$                                             | —                 | 5.5  |      | mV/V  |
| DC load regulation                                 | I <sub>REG</sub>     | Load current between 100 µA and 60 mA in EM0/EM1 mode                                                      | -                 | 0.27 | _    | mV/mA |
| Efficiency                                         | EFF                  | Load current between 100 $\mu$ A and 60 mA in EM0/EM1 mode, or between 10 $\mu$ A and 5 mA in EM2/EM3 mode | —                 | 91   |      | %     |
| Output load current                                | I <sub>LOAD</sub>    | EM0/EM1 mode, DCDC in regula-<br>tion                                                                      | —                 | —    | 60   | mA    |
| -                                                  |                      | EM2/EM3 mode, DCDC in regula-<br>tion                                                                      | —                 | _    | 5    | mA    |
|                                                    |                      | Bypass mode                                                                                                | —                 |      | 60   | mA    |
| Nominal output capacitor                           | C <sub>DCDC</sub>    | 4.7 $\mu$ F ± 10% X7R capacitor used for performance characterization <sup>2</sup>                         | 4.7               | _    | 10   | μF    |
| Nominal inductor                                   | L <sub>DCDC</sub>    | ± 20% tolerance                                                                                            | _                 | 2.2  | _    | μH    |
| Nominal input capacitor                            | C <sub>IN</sub>      |                                                                                                            | C <sub>DCDC</sub> | —    | _    | μF    |
| Resistance in bypass mode                          | R <sub>BYP</sub>     | Bypass switch from VREGVDD to DVDD, V <sub>VREGVDD</sub> = 1.8 V                                           | -                 | 1.75 | 3    | Ω     |
|                                                    |                      | Powertrain PFET switch from<br>VREGVDD to VREGSW,<br>V <sub>VREGVDD</sub> = 1.8 V                          | -                 | 0.86 | 1.5  | Ω     |
| Supply monitor threshold programming range         | V <sub>CMP_RNG</sub> | Programmable in 0.1 V steps                                                                                | 2.0               | _    | 2.3  | V     |
| Supply monitor threshold ac-<br>curacy             | V <sub>CMP_ACC</sub> | Supply falling edge trip point                                                                             | -5                | —    | 5    | %     |

| Parameter                              | Symbol                 | Test Condition                                                                        | Min | Тур | Max | Unit |
|----------------------------------------|------------------------|---------------------------------------------------------------------------------------|-----|-----|-----|------|
| Supply monitor threshold<br>hysteresis | V <sub>CMP_HYST</sub>  | Positive hysteresis on the supply rising edge referred to the falling edge trip point | _   | 4   | _   | %    |
| Supply monitor response time           | t <sub>CMP_DELAY</sub> | Supply falling edge at -100 mV / µs                                                   | _   | 0.6 |     | μs   |

Note:

1. The supported maximum V<sub>VREGVDD</sub> in regulation mode is a function of temperature and 10-year lifetime average load current. See more details in 4.4.1 DC-DC Operating Limits.

2. Samsung CL10B475KQ8NQNC used for performance characterization. Actual capacitor values can be significantly de-rated from their specified nominal value by the rated tolerance, as well as the application's AC voltage, DC bias, and temperature. The minimum capacitance counting all error sources should be no less than 2.4 μF.

#### 4.4.1 DC-DC Operating Limits

The maximum supported voltage on the VREGVDD supply pin is limited under certain conditions. Maximum input voltage is a function of temperature and the average load current over a 10-year lifetime. Figure 4.1 Lifetime average load current limit vs. Maximum input voltage on page 21 shows the safe operating region under specific conditions. Exceeding this safe operating range may impact the reliability and performance of the DC-DC converter.

The average load current for an application can typically be determined by examining the current profile during the time the device is powered. For example, an application that is continuously powered which spends 99% of the time asleep consuming 2  $\mu$ A and 1% of the time active and consuming 10 mA has an average lifetime load current of about 102  $\mu$ A.

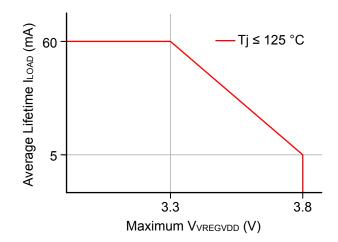


Figure 4.1. Lifetime average load current limit vs. Maximum input voltage

The minimum input voltage for the DC-DC in EM0/EM1 mode is a function of the maximum load current, and the peak current setting. Figure 4.2 Transient maximum load current vs. Minimum input voltage on page 21 shows the max load current vs. input voltage for different DC-DC peak inductor current settings.

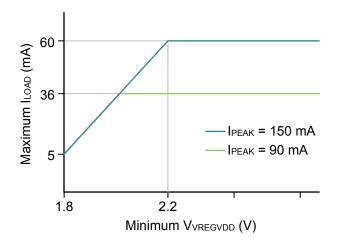


Figure 4.2. Transient maximum load current vs. Minimum input voltage

#### 4.5 Thermal Characteristics

| Parameter                                                              | Symbol                              | Test Condition                               | Min | Тур  | Мах | Unit |
|------------------------------------------------------------------------|-------------------------------------|----------------------------------------------|-----|------|-----|------|
| Thermal Resistance Junction<br>to Ambient QFN32 (4x4mm)<br>Package     | THE-<br>TA <sub>JA_QFN32_</sub> 4X4 | 4-Layer PCB, Natural Convection <sup>1</sup> | _   | 35.4 | _   | °C/W |
| Thermal Resistance, Junc-<br>tion to Ambient, QFN40<br>(5x5mm) Package | THE-<br>TA <sub>JA_QFN40_5X5</sub>  | 4-Layer PCB, Natural Convection <sup>1</sup> | _   | 32.6 | _   | °C/W |
| Note:                                                                  | 1                                   |                                              |     |      | 1   |      |

#### Table 4.4. Thermal Characteristics

1. Measured according to JEDEC standard JESD51-2A. Integrated Circuit Thermal Test Method Environmental Conditions - Natural Convection (Still Air).

#### 4.6 Current Consumption

#### 4.6.1 MCU current consumption using DC-DC at 3.0 V input

Unless otherwise indicated, typical conditions are: VREGVDD = 3.0 V. AVDD = DVDD = IOVDD = 1.8 V from DC-DC. Voltage scaling level = VSCALE1. T<sub>A</sub> = 25 °C. Minimum and maximum values in this table represent the worst conditions across process variation at T<sub>A</sub> = 25 °C.

#### Table 4.5. MCU current consumption using DC-DC at 3.0 V input

| Parameter                                                             | Symbol           | Test Condition                                                                                                  | Min | Тур | Max | Unit   |
|-----------------------------------------------------------------------|------------------|-----------------------------------------------------------------------------------------------------------------|-----|-----|-----|--------|
| Current consumption in EM0<br>mode with all peripherals dis-<br>abled | IACTIVE          | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running Prime from flash,<br>VSCALE2         | _   | 28  | _   | µA/MHz |
|                                                                       |                  | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running while loop from flash,<br>VSCALE2    |     | 27  | _   | µA/MHz |
|                                                                       |                  | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running CoreMark loop from flash,<br>VSCALE2 |     | 37  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running<br>Prime from flash                                                               | _   | 28  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running while loop from flash                                                             | _   | 26  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running<br>CoreMark loop from flash                                                       | _   | 38  | _   | µA/MHz |
|                                                                       |                  | 38 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 22  | _   | µA/MHz |
|                                                                       |                  | 26 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 24  | _   | µA/MHz |
|                                                                       |                  | 16 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 27  | _   | µA/MHz |
|                                                                       |                  | 1 MHz HFRCO, CPU running while loop from flash                                                                  | _   | 159 | _   | µA/MHz |
| Current consumption in EM1 mode with all peripherals disabled         | I <sub>EM1</sub> | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal,<br>VSCALE2                                          | _   | 17  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal                                                                                                |     | 17  | _   | µA/MHz |
|                                                                       |                  | 38 MHz HFRCO                                                                                                    | _   | 13  | _   | µA/MHz |
|                                                                       |                  | 26 MHz HFRCO                                                                                                    | —   | 15  | _   | µA/MHz |
|                                                                       |                  | 16 MHz HFRCO                                                                                                    | —   | 18  | —   | µA/MHz |
|                                                                       |                  | 1 MHz HFRCO                                                                                                     | _   | 150 | _   | µA/MHz |

| Parameter                                                                                  | Symbol               | Test Condition                                                               | Min | Тур  | Max | Unit |
|--------------------------------------------------------------------------------------------|----------------------|------------------------------------------------------------------------------|-----|------|-----|------|
| Current consumption in EM2<br>mode, VSCALE0                                                | I <sub>EM2_VS</sub>  | Full RAM retention and RTC run-<br>ning from LFXO                            | _   | 1.30 | _   | μA   |
|                                                                                            |                      | Full RAM retention and RTC run-<br>ning from LFRCO                           | —   | 1.30 | _   | μA   |
|                                                                                            |                      | Full RAM retention and RTC run-<br>ning from LFRCO in precision<br>mode      | _   | 1.65 | _   | μΑ   |
|                                                                                            |                      | 24 kB RAM retention and RTC running from LFXO                                | _   | 1.22 | _   | μA   |
|                                                                                            |                      | 24 kB RAM retention and RTC running from LFRCO in precision mode             | _   | 1.56 | _   | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFXO                            | _   | 1.11 | _   | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFRCO                           | —   | 1.10 | _   | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFXO, CPU cache not<br>retained | _   | 1.03 | _   | μA   |
| Current consumption in EM3 mode, VSCALE0                                                   | I <sub>EM3_VS</sub>  | 8 kB RAM retention and RTC run-<br>ning from ULFRCO                          | _   | 0.95 | _   | μA   |
| Additional current in EM2 or<br>EM3 when any peripheral in<br>PD0B is enabled <sup>1</sup> | I <sub>PD0B_VS</sub> |                                                                              | _   | 0.37 | _   | μΑ   |

#### Note:

1. Extra current consumed by power domain. Does not include current associated with the enabled peripherals. See for a list of the peripherals in each power domain.

#### 4.6.2 MCU current consumption at 3.0 V

Unless otherwise indicated, typical conditions are: AVDD = DVDD = IOVDD = VREGVDD = 3.0 V. DC-DC not used. Voltage scaling level = VSCALE1.  $T_A = 25$  °C. Minimum and maximum values in this table represent the worst conditions across process variation at  $T_A = 25$  °C.

| Parameter                                                             | Symbol           | Test Condition                                                                                                  | Min | Тур | Max | Unit   |
|-----------------------------------------------------------------------|------------------|-----------------------------------------------------------------------------------------------------------------|-----|-----|-----|--------|
| Current consumption in EM0<br>mode with all peripherals dis-<br>abled | IACTIVE          | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running Prime from flash,<br>VSCALE2         | _   | 42  | _   | µA/MHz |
|                                                                       |                  | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running while loop from flash,<br>VSCALE2    |     | 39  |     | µA/MHz |
|                                                                       |                  | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running CoreMark loop from flash,<br>VSCALE2 | _   | 54  |     | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running<br>Prime from flash                                                               | _   | 40  |     | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running while loop from flash                                                             | _   | 39  |     | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running<br>CoreMark loop from flash                                                       | _   | 55  |     | µA/MHz |
|                                                                       |                  | 38 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 33  | 50  | µA/MHz |
|                                                                       |                  | 26 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 35  |     | µA/MHz |
|                                                                       |                  | 16 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 40  |     | µA/MHz |
|                                                                       |                  | 1 MHz HFRCO, CPU running while loop from flash                                                                  | _   | 228 | 830 | µA/MHz |
| Current consumption in EM1 mode with all peripherals disabled         | I <sub>EM1</sub> | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal,<br>VSCALE2                                          | —   | 24  |     | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal                                                                                                | _   | 25  |     | µA/MHz |
|                                                                       |                  | 38 MHz HFRCO                                                                                                    | _   | 19  | 35  | µA/MHz |
|                                                                       |                  | 26 MHz HFRCO                                                                                                    | _   | 21  |     | µA/MHz |
|                                                                       |                  | 16 MHz HFRCO                                                                                                    | —   | 27  | _   | µA/MHz |
|                                                                       |                  | 1 MHz HFRCO                                                                                                     | _   | 215 | 770 | µA/MHz |

#### Table 4.6. MCU current consumption at 3.0 V

| Parameter                                                                                  | Symbol               | Test Condition                                                               | Min | Тур  | Max  | Unit |
|--------------------------------------------------------------------------------------------|----------------------|------------------------------------------------------------------------------|-----|------|------|------|
| Current consumption in EM2 mode, VSCALE0                                                   | I <sub>EM2_VS</sub>  | Full RAM retention and RTC run-<br>ning from LFXO                            | _   | 1.74 | _    | μA   |
|                                                                                            |                      | Full RAM retention and RTC run-<br>ning from LFRCO                           | _   | 1.75 | 4.9  | μA   |
|                                                                                            |                      | 24 kB RAM retention and RTC running from LFXO                                | _   | 1.61 |      | μA   |
|                                                                                            |                      | 24 kB RAM retention and RTC running from LFRCO in precision mode             | _   | 2.14 | _    | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFXO                            | _   | 1.44 | _    | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFRCO                           | _   | 1.45 | _    | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFXO, CPU cache not<br>retained | _   | 1.39 | _    | μA   |
| Current consumption in EM3 mode, VSCALE0                                                   | I <sub>EM3_VS</sub>  | 8 kB RAM retention and RTC run-<br>ning from ULFRCO                          | —   | 1.21 | 3.7  | μA   |
| Current consumption in EM4                                                                 | I <sub>EM4</sub>     | No BURTC, no LF oscillator                                                   | _   | 0.17 | 0.43 | μA   |
| mode                                                                                       |                      | BURTC with LFXO                                                              | _   | 0.50 | _    | μA   |
| Current consumption during reset                                                           | I <sub>RST</sub>     | Hard pin reset held                                                          | _   | 234  | _    | μA   |
| Additional current in EM2 or<br>EM3 when any peripheral in<br>PD0B is enabled <sup>1</sup> | I <sub>PD0B_VS</sub> |                                                                              | _   | 0.56 | _    | μΑ   |

#### Note:

1. Extra current consumed by power domain. Does not include current associated with the enabled peripherals. See for a list of the peripherals in each power domain.

#### 4.6.3 MCU current consumption at 1.8 V

Unless otherwise indicated, typical conditions are: AVDD = DVDD = IOVDD = VREGVDD = 1.8 V. DC-DC not used. Voltage scaling level = VSCALE1.  $T_A = 25$  °C. Minimum and maximum values in this table represent the worst conditions across process variation at  $T_A = 25$  °C.

| Parameter                                                             | Symbol           | Test Condition                                                                                                  | Min | Тур | Max | Unit   |
|-----------------------------------------------------------------------|------------------|-----------------------------------------------------------------------------------------------------------------|-----|-----|-----|--------|
| Current consumption in EM0<br>mode with all peripherals dis-<br>abled | IACTIVE          | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running Prime from flash,<br>VSCALE2         | —   | 42  | _   | µA/MHz |
|                                                                       |                  | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running while loop from flash,<br>VSCALE2    |     | 39  | _   | µA/MHz |
|                                                                       |                  | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal, CPU<br>running CoreMark loop from flash,<br>VSCALE2 |     | 54  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running<br>Prime from flash                                                               |     | 41  |     | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running while loop from flash                                                             | _   | 39  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal, CPU running<br>CoreMark loop from flash                                                       | _   | 55  | _   | µA/MHz |
|                                                                       |                  | 38 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 33  | _   | µA/MHz |
|                                                                       |                  | 26 MHz HFRCO, CPU running while loop from flash                                                                 | _   | 35  | _   | µA/MHz |
|                                                                       |                  | 16 MHz HFRCO, CPU running while loop from flash                                                                 | —   | 40  | _   | µA/MHz |
|                                                                       |                  | 1 MHz HFRCO, CPU running while loop from flash                                                                  | —   | 227 |     | µA/MHz |
| Current consumption in EM1<br>mode with all peripherals dis-<br>abled | I <sub>EM1</sub> | 76.8 MHz HFRCO w/ DPLL refer-<br>enced to 38.4 MHz crystal,<br>VSCALE2                                          | —   | 24  | _   | µA/MHz |
|                                                                       |                  | 38.4 MHz crystal                                                                                                | _   | 25  |     | µA/MHz |
|                                                                       |                  | 38 MHz HFRCO                                                                                                    | _   | 19  | _   | µA/MHz |
|                                                                       |                  | 26 MHz HFRCO                                                                                                    | _   | 21  | _   | µA/MHz |
|                                                                       |                  | 16 MHz HFRCO                                                                                                    | —   | 27  | _   | µA/MHz |
|                                                                       |                  | 1 MHz HFRCO                                                                                                     | _   | 213 | _   | µA/MHz |

#### Table 4.7. MCU current consumption at 1.8 V

| Parameter                                                                                  | Symbol               | Test Condition                                                               | Min | Тур  | Мах | Unit |
|--------------------------------------------------------------------------------------------|----------------------|------------------------------------------------------------------------------|-----|------|-----|------|
| Current consumption in EM2<br>mode, VSCALE0                                                | I <sub>EM2_VS</sub>  | Full RAM retention and RTC run-<br>ning from LFXO                            | _   | 1.67 | _   | μA   |
|                                                                                            |                      | Full RAM retention and RTC run-<br>ning from LFRCO                           | _   | 1.66 | _   | μA   |
|                                                                                            |                      | 24 kB RAM retention and RTC running from LFXO                                | _   | 1.53 |     | μA   |
|                                                                                            |                      | 24 kB RAM retention and RTC<br>running from LFRCO in precision<br>mode       | _   | 2.06 | —   | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFXO                            | _   | 1.37 | —   | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFRCO                           | _   | 1.36 | _   | μA   |
|                                                                                            |                      | 8 kB RAM retention and RTC run-<br>ning from LFXO, CPU cache not<br>retained | _   | 1.32 | _   | μA   |
| Current consumption in EM3 mode, VSCALE0                                                   | I <sub>EM3_VS</sub>  | 8 kB RAM retention and RTC run-<br>ning from ULFRCO                          | —   | 1.14 | —   | μA   |
| Current consumption in EM4                                                                 | I <sub>EM4</sub>     | No BURTC, no LF oscillator                                                   | _   | 0.13 |     | μA   |
| mode                                                                                       |                      | BURTC with LFXO                                                              | _   | 0.44 | _   | μA   |
| Current consumption during reset                                                           | I <sub>RST</sub>     | Hard pin reset held                                                          | _   | 190  | _   | μA   |
| Additional current in EM2 or<br>EM3 when any peripheral in<br>PD0B is enabled <sup>1</sup> | I <sub>PD0B_VS</sub> |                                                                              | _   | 0.54 | —   | μA   |

#### Note:

1. Extra current consumed by power domain. Does not include current associated with the enabled peripherals. See for a list of the peripherals in each power domain.

#### 4.7 Flash Characteristics

| Parameter                                      | Symbol               | Test Condition                  | Min    | Тур  | Max  | Unit   |
|------------------------------------------------|----------------------|---------------------------------|--------|------|------|--------|
| Flash Supply voltage during write or erase     | V <sub>FLASH</sub>   |                                 | 1.71   | _    | 3.8  | V      |
| Flash erase cycles before failure <sup>1</sup> | EC <sub>FLASH</sub>  |                                 | 10,000 | _    | _    | cycles |
| Flash data retention <sup>1</sup>              | RET <sub>FLASH</sub> |                                 | 10     | _    | _    | years  |
| Program Time                                   | t <sub>PROG</sub>    | one word (32-bits)              | 42.1   | 44   | 45.6 | uSec   |
|                                                |                      | average per word over 128 words | 10.3   | 10.9 | 11.3 | uSec   |
| Page Erase Time                                | t <sub>PERASE</sub>  |                                 | 11.4   | 12.9 | 14.4 | ms     |
| Mass Erase Time                                | t <sub>MERASE</sub>  | Erases all of User Code area    | 11.7   | 13   | 14.3 | ms     |
| Program Current                                | I <sub>PROG</sub>    |                                 | _      |      | 1.45 | mA     |
| Page Erase Current                             | I <sub>PERASE</sub>  | Page Erase                      | _      |      | 1.34 | mA     |
| Mass Erase Current                             | I <sub>MERASE</sub>  | Mass Erase                      | _      | _    | 1.28 | mA     |
| Note:                                          | 1                    | 1                               |        |      | 1    |        |

#### Table 4.8. Flash Characteristics

1. Flash data retention information is published in the Quarterly Quality and Reliability Report.

#### 4.8 Wake Up, Entry, and Exit times

Unless otherwise specified, these times are measured using the HFRCO at 19 MHz.

#### Table 4.9. Wake Up, Entry, and Exit times

| Parameter                  | Symbol               | Test Condition                                   | Min | Тур   | Max | Unit  |
|----------------------------|----------------------|--------------------------------------------------|-----|-------|-----|-------|
| WakeupTime from EM1        | t <sub>EM1_WU</sub>  | Code execution from flash                        |     | 3     |     | HCLKs |
|                            |                      | Code execution from RAM                          | _   | 1.42  |     | μs    |
| WakeupTime from EM2        | t <sub>EM2_WU</sub>  | Code execution from flash, No<br>Voltage Scaling | _   | 13.22 | _   | μs    |
|                            |                      | Code execution from RAM, No<br>Voltage Scaling   | _   | 5.15  | _   | μs    |
|                            |                      | Voltage scaling up one level <sup>1</sup>        | _   | 37.89 |     | μs    |
|                            |                      | Voltage scaling up two levels <sup>2</sup>       | _   | 50.56 | _   | μs    |
| WakupTime from EM3         | t <sub>EM3_WU</sub>  | Code execution from flash, No<br>Voltage Scaling | _   | 13.21 |     | μs    |
|                            |                      | Code execution from RAM, No<br>Voltage Scaling   | _   | 5.15  |     | μs    |
|                            |                      | Voltage scaling up one level <sup>1</sup>        | _   | 37.90 | _   | μs    |
|                            |                      | Voltage scaling up two levels <sup>2</sup>       | _   | 50.55 | _   | μs    |
| WakeupTime from EM4        | t <sub>EM4_WU</sub>  | Code execution from flash                        | _   | 8.81  |     | ms    |
| Entry time to EM1          | t <sub>EM1_ENT</sub> | Code execution from flash                        | _   | 1.29  |     | μs    |
| Entry time to EM2          | t <sub>EM2_ENT</sub> | Code execution from flash                        | _   | 5.23  | _   | μs    |
| Entry time to EM3          | t <sub>EM3_ENT</sub> | Code execution from flash                        | _   | 5.23  | _   | μs    |
| Entry time to EM4          | t <sub>EM4_ENT</sub> | Code execution from flash                        | _   | 9.96  | _   | μs    |
| Voltage scaling in time in | t <sub>SCALE</sub>   | Up from VSCALE1 to VSCALE2                       | _   | 32    |     | μs    |
| EM0 <sup>3</sup>           |                      | Down from VSCALE2 to<br>VSCALE1                  | _   | 172   |     | μs    |

Note:

1. Voltage scaling one level is between VSCALE0 and VSCALE1 or between VSCALE1 and VSCALE2.

2. Voltage scaling two levels is between VSCALE0 and VSCALE2.

3. During voltage scaling in EM0, RAM is inaccessible and processor will be halted until complete.

#### 4.9 Oscillators

#### 4.9.1 High Frequency Crystal Oscillator

Unless otherwise indicated, typical conditions are: AVDD = DVDD = 3.0 V. T<sub>A</sub> = 25 °C. Minimum and maximum values in this table represent the worst conditions across process variation, operating supply voltage range, and operating temperature range.

#### Table 4.10. High Frequency Crystal Oscillator

| Parameter                                                | Symbol                   | Test Condition                        | Min | Тур  | Max | Unit |
|----------------------------------------------------------|--------------------------|---------------------------------------|-----|------|-----|------|
| Crystal Frequency                                        | F <sub>HFXO</sub>        |                                       | _   | 38.4 | _   | MHz  |
| Supported crystal equivalent series resistance (ESR)     | ESR <sub>HFXO_38M4</sub> | 38.4 MHz, CL = 10 pF <sup>1</sup>     |     | 40   | 60  | Ω    |
| Supported range of crystal load capacitance <sup>2</sup> | C <sub>HFXO_LC</sub>     | 38.4 MHz, ESR = 40 Ω                  | _   | 10   | _   | pF   |
| Supply Current                                           | I <sub>HFXO</sub>        |                                       | _   | 415  | _   | μA   |
| Startup Time <sup>3</sup>                                | T <sub>STARTUP</sub>     | 38.4 MHz, ESR = 40 Ohm, CL =<br>10 pF |     | 160  |     | μs   |
| On-chip tuning cap step size <sup>4</sup>                | SS <sub>HFXO</sub>       |                                       | _   | 0.04 |     | pF   |

#### Note:

1. The crystal should have a maximum ESR less than or equal to this maximum rating.

2. Total load capacitance as seen by the crystal.

3. Startup time does not include time implemented by programmable TIMEOUTSTEADY delay.

4. The tuning step size is the effective step size when incrementing both of the tuning capacitors by one count. The step size for the each of the individual tuning capacitors is twice this value.

#### 4.9.2 Low Frequency Crystal Oscillator

| Parameter                                                           | Symbol                | Test Condition                                                              | Min  | Тур    | Мах  | Unit |
|---------------------------------------------------------------------|-----------------------|-----------------------------------------------------------------------------|------|--------|------|------|
| Crystal Frequency                                                   | F <sub>LFXO</sub>     |                                                                             | _    | 32.768 | _    | kHz  |
| Supported Crystal equivalent                                        | ESR <sub>LFXO</sub>   | GAIN = 0                                                                    | _    | _      | 80   | kΩ   |
| series resistance (ESR)                                             |                       | GAIN = 1 to 3                                                               | _    | —      | 100  | kΩ   |
| Supported range of crystal                                          | C <sub>LFXO_CL</sub>  | GAIN = 0                                                                    | 4    | _      | 6    | pF   |
| load capacitance <sup>1</sup>                                       |                       | GAIN = 1                                                                    | 6    | —      | 10   | pF   |
|                                                                     |                       | GAIN = 2 (see note <sup>2</sup> )                                           | 10   | _      | 12.5 | pF   |
|                                                                     |                       | GAIN = 3 (see note <sup>2</sup> )                                           | 12.5 | —      | 18   | pF   |
| Current consumption                                                 | I <sub>CL12p5</sub>   | ESR = 70 kOhm, CL = 12.5 pF,<br>GAIN <sup>3</sup> = 2, AGC <sup>4</sup> = 1 | _    | 357    | _    | nA   |
| Startup Time                                                        | T <sub>STARTUP</sub>  | ESR = 70 kOhm, CL = 7 pF,<br>GAIN <sup>3</sup> = 1, AGC <sup>4</sup> = 1    | _    | 63     | _    | ms   |
| On-chip tuning cap step size                                        | SS <sub>LFXO</sub>    |                                                                             | _    | 0.26   |      | pF   |
| On-chip tuning capacitor val-<br>ue at minimum setting <sup>5</sup> | C <sub>LFXO_MIN</sub> | CAPTUNE = 0                                                                 | -    | 4      | _    | pF   |
| On-chip tuning capacitor val-<br>ue at maximum setting <sup>5</sup> | C <sub>LFXO_MAX</sub> | CAPTUNE = 0x4F                                                              | -    | 24.5   | _    | pF   |

#### Table 4.11. Low Frequency Crystal Oscillator

#### Note:

1. Total load capacitance seen by the crystal

2. Crystals with a load capacitance of greater than 12 pF require external load capacitors.

3. In LFXO\_CAL Register

4. In LFXO\_CFG Register

5. The effective load capacitance seen by the crystal will be C<sub>LFXO</sub>/2. This is because each XTAL pin has a tuning cap and the two caps will be seen in series by the crystal

#### 4.9.3 High Frequency RC Oscillator (HFRCO)

Unless otherwise indicated, typical conditions are: AVDD = DVDD = 3.0 V. T<sub>A</sub> = 25 °C. Minimum and maximum values in this table represent the worst conditions across process variation, operating supply voltage range, and operating temperature range.

| Parameter                                       | Symbol                 | Test Condition                                 | Min | Тур | Max | Unit   |
|-------------------------------------------------|------------------------|------------------------------------------------|-----|-----|-----|--------|
| Frequency Accuracy                              | F <sub>HFRCO_ACC</sub> | For all production calibrated fre-<br>quencies | -3  | _   | 3   | %      |
| Current consumption on all                      | I <sub>HFRCO</sub>     | F <sub>HFRCO</sub> = 1 MHz                     | _   | 28  | _   | μΑ     |
| supplies <sup>1</sup>                           |                        | F <sub>HFRCO</sub> = 2 MHz                     | _   | 28  | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 4 MHz                     | —   | 28  | _   | μΑ     |
|                                                 |                        | F <sub>HFRCO</sub> = 5 MHz                     | —   | 30  | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 7 MHz                     | —   | 60  | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 10 MHz                    | —   | 66  | _   | μΑ     |
|                                                 |                        | F <sub>HFRCO</sub> = 13 MHz                    | _   | 79  | _   | μΑ     |
|                                                 |                        | F <sub>HFRCO</sub> = 16 MHz                    | _   | 88  | _   | μΑ     |
|                                                 |                        | F <sub>HFRCO</sub> = 19 MHz                    | _   | 92  | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 20 MHz                    | _   | 105 | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 26 MHz                    | _   | 118 | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 32 MHz                    | —   | 141 | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 38 MHz                    | —   | 172 | _   | μA     |
|                                                 |                        | F <sub>HFRCO</sub> = 80 MHz                    | _   | 289 | _   | μΑ     |
| Clock out current for<br>HFRCODPLL <sup>2</sup> | ICLKOUT_HFRCOD         | FORCEEN bit of HFRCO0_CTRL<br>= 1              | _   | 3.0 | _   | µA/MHz |
| Startup Time <sup>3</sup>                       | T <sub>STARTUP</sub>   | FREQRANGE = 0 to 7                             | —   | 1.2 | _   | μs     |
|                                                 |                        | FREQRANGE = 8 to 15                            | —   | 0.6 | -   | μs     |

#### Table 4.12. High Frequency RC Oscillator (HFRCO)

| Parameter                          | Symbol                  | Test Condition | Min  | Тур | Max  | Unit |
|------------------------------------|-------------------------|----------------|------|-----|------|------|
| Band Frequency Limits <sup>4</sup> | f <sub>HFRCO_BAND</sub> | FREQRANGE = 0  | 3.71 |     | 5.24 | MHz  |
|                                    |                         | FREQRANGE = 1  | 4.39 | _   | 6.26 | MHz  |
|                                    |                         | FREQRANGE = 2  | 5.25 | _   | 7.55 | MHz  |
|                                    |                         | FREQRANGE = 3  | 6.22 |     | 9.01 | MHz  |
|                                    |                         | FREQRANGE = 4  | 7.88 | _   | 11.6 | MHz  |
|                                    |                         | FREQRANGE = 5  | 9.9  |     | 14.6 | MHz  |
|                                    |                         | FREQRANGE = 6  | 11.5 | _   | 17.0 | MHz  |
|                                    |                         | FREQRANGE = 7  | 14.1 |     | 20.9 | MHz  |
|                                    |                         | FREQRANGE = 8  | 16.4 |     | 24.7 | MHz  |
|                                    |                         | FREQRANGE = 9  | 19.8 | _   | 30.4 | MHz  |
|                                    |                         | FREQRANGE = 10 | 22.7 |     | 34.9 | MHz  |
|                                    |                         | FREQRANGE = 11 | 28.6 |     | 44.4 | MHz  |
|                                    |                         | FREQRANGE = 12 | 33.0 | _   | 51.0 | MHz  |
|                                    |                         | FREQRANGE = 13 | 42.2 | _   | 64.6 | MHz  |
|                                    |                         | FREQRANGE = 14 | 48.8 | _   | 74.8 | MHz  |
|                                    |                         | FREQRANGE = 15 | 57.6 | _   | 87.4 | MHz  |

#### Note:

1. Does not include additional clock tree current. See specifications for additional current when selected as a clock source for a particular clock multiplexer.

2. When the HFRCO is enabled for characterization using the FORCEEN bit, the total current will be the HFRCO core current plus the specified CLKOUT current. When the HFRCO is enabled on demand, the clock current may be different.

3. Hardware delay ensures settling to within  $\pm$  0.5%. Hardware also enforces this delay on a band change.

4. The frequency band limits represent the lowest and highest frequency which each band can achieve over the operating range.

#### 4.9.4 Fast Start\_Up RC Oscillator (FSRCO)

#### Table 4.13. Fast Start\_Up RC Oscillator (FSRCO)

| Parameter       | Symbol             | Test Condition | Min  | Тур | Мах  | Unit |
|-----------------|--------------------|----------------|------|-----|------|------|
| FSRCO frequency | F <sub>FSRCO</sub> |                | 17.2 | 20  | 21.2 | MHz  |

#### 4.9.5 Low Frequency RC Oscillator (LFRCO)

#### Table 4.14. Low Frequency RC Oscillator (LFRCO)

| Parameter                          | Symbol                 | Test Condition | Min | Тур    | Max | Unit |
|------------------------------------|------------------------|----------------|-----|--------|-----|------|
| Nominal oscillation frequen-<br>cy | F <sub>LFRCO</sub>     |                | _   | 32.768 | —   | kHz  |
| Frequency accuracy                 | F <sub>LFRCO_ACC</sub> |                | -3  | —      | 3   | %    |
| Startup time                       | tSTARTUP               |                | —   | 204    | —   | μs   |
| Current consumption                | I <sub>LFRCO</sub>     |                | —   | 175    | _   | nA   |

#### 4.9.6 Ultra Low Frequency RC Oscillator

#### Table 4.15. Ultra Low Frequency RC Oscillator

| Parameter             | Symbol              | Test Condition | Min   | Тур | Мах   | Unit |
|-----------------------|---------------------|----------------|-------|-----|-------|------|
| Oscillation Frequency | F <sub>ULFRCO</sub> |                | 0.944 | 1.0 | 1.095 | kHz  |

#### 4.10 GPIO Pins (3V GPIO pins)

| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Unit | Max       | Тур  | Min       | Test Condition                                                                 | Symbol                 | Parameter                            |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----------|------|-----------|--------------------------------------------------------------------------------|------------------------|--------------------------------------|
| 3.0 V         Image         Mark                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | nA   | —         | 1.9  | —         |                                                                                | I <sub>LEAK_IO</sub>   | Leakage current                      |
| $ \frac{PR00, PC03, PC04 and PD00; \\ \frac{OODEx = DisABLED, IOVDD = }{3.8 \vee T_A = 125 C} \\ \frac{Pins PA00, PA03, PB00, PC03, PC04 and PD00; MODEx = DISA, BLED, IOVDD = 3.8 \vee T_A = 125 C}{C} \\ \frac{Pins PA00, PA03, PB00, PC03, PC03, PC04 and PD00; MODEx = DISA, BLED, IOVDD = 3.8 \vee T_A = 125 C}{C} \\ \frac{Pins PA00, PA03, PB00, PC03, PC03, PC04 and PD00; MODEx = DISA, BLED, IOVDD = 3.8 \vee T_A = 125 C}{C} \\ \frac{Pins PA00, PA03, PB00, PC03, PC04 and PD00; MODEx = DISA, BLED, IOVDD = 3.8 \vee T_A = 125 C}{C} \\ Pins PA00, PA03, PB00, PC03, PC04 and PD00; MODEx = DISA, BLED, IOVDD = 0.03*IOVDD$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | nA   | —         | 2.5  | _         |                                                                                |                        |                                      |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | nA   | 200       | _    | _         | PB00, PC03, PC04 and PD00;<br>MODEx = DISABLED, IOVDD =                        |                        |                                      |
| $ \frac{1}{10000000000000000000000000000000000$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | nA   | 550       | _    | _         | PC04 and PD00; MODEx = DISA-<br>BLED, IOVDD = $3.8 \text{ V T}_{A}$ = 125      |                        |                                      |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |      | 0.3*IOVDD | —    | _         | Any GPIO pin                                                                   | V <sub>IL</sub>        | Input low voltage <sup>1</sup>       |
| $ \frac{1}{\text{RESETn}} = \frac{1}{\text{RESETn}} = \frac{1}{10000000000000000000000000000000000$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | V    | 0.3*DVDD  | _    | _         | RESETn                                                                         |                        |                                      |
| Hysteresis of input voltage $V_{HYS}$ Any GPIO pin $0.05*10VD$<br>D $$ $-$ Output high voltage $V_{OH}$ Sourcing 20mA, IOVDD = 3.0 V $0.8*$<br>IOVDD $$ $-$ Output low voltage $V_{OH}$ Sourcing 8mA, IOVDD = 1.71 V $0.6*$<br>IOVDD $$ $-$ Output low voltage $V_{OL}$ Sinking 20mA, IOVDD = 3.0 V $0.6*$<br>IOVDD $$ $-$ Output low voltage $V_{OL}$ Sinking 20mA, IOVDD = 1.71 V $0.6*$<br>IOVDD $$ $-$ Output low voltage $V_{OL}$ Sinking 8mA, IOVDD = 1.71 V $$ $$ $0.2*$<br>IOVDDGPIO rise time $T_{GPIO_RISE}$ IOVDD = 3.0 V, $C_{load}$ = 50pF,<br>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | V    | —         | _    | 0.7*IOVDD | Any GPIO pin                                                                   | V <sub>IH</sub>        | Input high voltage <sup>1</sup>      |
| $ \frac{P_{A}}{P_{A}} = \frac{P_{A}}{P_{A}} + \frac{P_{A}}{$ | V    | —         | —    | 0.7*DVDD  | RESETn                                                                         |                        |                                      |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | V    | —         | _    |           | Any GPIO pin                                                                   | V <sub>HYS</sub>       | Hysteresis of input voltage          |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | V    | —         |      | 0.05*DVDD | RESETn                                                                         |                        |                                      |
| Output low voltage $V_{OL}$ Sinking 20mA, IOVDD = $3.0$ V $$ $0.2^*$<br>IOVDDOutput low voltage $V_{OL}$ Sinking 20mA, IOVDD = $3.0$ V $$ $0.2^*$<br>IOVDDSinking 8mA, IOVDD = $1.71$ V $$ $$ $0.4^*$<br>IOVDDGPIO rise time $T_{GPIO\_RISE}$ IOVDD = $3.0$ V, $C_{Ioad}$ = $50pF$ ,<br>SLEWRATE = $4, 10\%$ to $90\%$ $$ $8.4$ $$ GPIO fall time $T_{GPIO\_RISE}$ IOVDD = $1.71$ V, $C_{Ioad}$ = $50pF$ ,<br>SLEWRATE = $4, 10\%$ to $90\%$ $$ $13$ $$ GPIO fall time $T_{GPIO\_FALL}$ IOVDD = $3.0$ V, $C_{Ioad}$ = $50pF$ ,<br>SLEWRATE = $4, 90\%$ to $10\%$ $$ $11.9$ $$ Pull up/down resistance <sup>2</sup> RPULLAny GPIO pin. Pull-up to IOVDD:<br>NODEn = DISABLE DOUT=1.<br>Pull-down to VSS: MODEn = $35$ $44$ $55$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | V    | —         | _    |           | Sourcing 20mA, IOVDD = 3.0 V                                                   | V <sub>OH</sub>        | Output high voltage                  |
| $\frac{1}{10000000000000000000000000000000000$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | V    | —         | _    |           | Sourcing 8mA, IOVDD = 1.71 V                                                   |                        |                                      |
| $\frac{1}{\text{GPIO rise time}}  \begin{array}{ c c c c c c } \hline \text{IOVDD} & & & & & & & & & & & & & & & & & & $                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | V    |           | _    | _         | Sinking 20mA, IOVDD = 3.0 V                                                    | V <sub>OL</sub>        | Output low voltage                   |
| $\frac{SLEWRATE = 4, 10\% \text{ to } 90\%}{IOVDD = 1.71 \text{ V}, C_{load} = 50\text{pF}, } - 13 - 13 - 10\% \text{ to } 90\%}$ $\frac{GPIO \text{ fall time}}{T_{GPIO\_FALL}} = \frac{T_{GPIO\_FALL}}{IOVDD = 3.0 \text{ V}, C_{load} = 50\text{pF}, } - 7.1 - 10\% \text{ to } 90\%}$ $\frac{IOVDD = 3.0 \text{ V}, C_{load} = 50\text{pF}, }{SLEWRATE = 4, 90\% \text{ to } 10\%} - 11.9 - 11.9 - 10\% \text{ sleWRATE} = 4, 90\% \text{ to } 10\%}$ $Pull \text{ up/down resistance}^2 = R_{PULL} = \frac{Any GPIO \text{ pin. Pull-up to } IOVDD: }{MODEn = DISABLE DOUT=1.} 35 - 44}$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | V    | 1 1       | _    | —         | Sinking 8mA, IOVDD = 1.71 V                                                    |                        |                                      |
| $ \begin{array}{ c c c c c c } \hline SLEWRATE = 4, 10\% \ to \ 90\% \\ \hline GPIO \ fall \ time \\ \hline T_{GPIO\_FALL} \\ \hline T_{GPIO\_FALL} \\ \hline \\ IOVDD = 3.0 \ V, \ C_{load} = 50pF, \\ SLEWRATE = 4, 90\% \ to \ 10\% \\ \hline \\ IOVDD = 1.71 \ V, \ C_{load} = 50pF, \\ SLEWRATE = 4, 90\% \ to \ 10\% \\ \hline \\ SLEWRATE = 4, 90\% \ to \ 10\% \\ \hline \\ Pull \ up/down \ resistance^2 \\ \hline \\ R_{PULL} \\ \hline \\ R_{PUL} \\ \hline \\ R_{PULL} \\ \hline \\ R_{PUL} \\ \hline \\ \\ R_{PUL} \\ \hline \\ R_{PUL} \\ \hline \\ \\ R_{PUL} \\ \hline \\ \\ R_{PUL} \\ \hline \\ R_{PUL} \\ \hline \\ \\ \\ R_{PUL} \\ \hline \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | ns   | —         | 8.4  | —         |                                                                                | T <sub>GPIO_RISE</sub> | GPIO rise time                       |
| SLEWRATE = 4, 90% to 10% $SLEWRATE = 4, 90\% to 10\%$ $IOVDD = 1.71 V, C_{load} = 50pF,$<br>SLEWRATE = 4, 90% to 10%Pull up/down resistance <sup>2</sup> $R_{PULL}$ Any GPIO pin. Pull-up to IOVDD:<br>MODEn = DISABLE DOUT=1.<br>Pull-down to VSS: MODEn =                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | ns   | —         | 13   | _         |                                                                                |                        |                                      |
| Pull up/down resistance <sup>2</sup> R <sub>PULL</sub> Any GPIO pin. Pull-up to IOVDD:<br>MODEn = DISABLE DOUT=1.<br>Pull-down to VSS: MODEn =       35       44       55                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | ns   | —         | 7.1  | _         |                                                                                | T <sub>GPIO_FALL</sub> | GPIO fall time                       |
| MODEn = DISABLE DOUT=1.<br>Pull-down to VSS: MODEn =                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | ns   | -         | 11.9 | _         |                                                                                |                        |                                      |
| 0.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | kΩ   | 55        | 44   | 35        | MODEn = DISABLE DOUT=1.<br>Pull-down to VSS: MODEn =<br>WIREDORPULLDOWN DOUT = | R <sub>PULL</sub>      | Pull up/down resistance <sup>2</sup> |
| RESETn pin. Pull-up to DVDD 35 44 55                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | kΩ   | 55        | 44   | 35        | RESETn pin. Pull-up to DVDD                                                    |                        |                                      |
| Maximum filtered glitch width $T_{GF}$ MODE = INPUT, DOUT = 1 $-$ 27 $-$                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | ns   | _         | 27   | _         | MODE = INPUT, DOUT = 1                                                         | T <sub>GF</sub>        | Maximum filtered glitch width        |

#### Table 4.16. GPIO Pins (3V GPIO pins)

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| Parameter                            | Symbol               | Test Condition                    | Min           | Тур            | Max | Unit |
|--------------------------------------|----------------------|-----------------------------------|---------------|----------------|-----|------|
| RESETn low time to ensure pin reset  | T <sub>RESET</sub>   |                                   | 100           |                | _   | ns   |
| Note:<br>1. GPIO input thresholds ar | e proportional to th | e IOVDD pin. RESETn input thresho | lds are propo | rtional to DVI | DD. |      |

2. GPIO pull-ups connect to IOVDD supply, pull-downs connect to VSS. RESETn pull-up connects to DVDD.

## 4.11 Analog to Digital Converter (IADC)

Specified at 1 Msps, ADCCLK = 10 MHz, OSR=2, unless otherwise indicated.

| Table 4.17. | Analog to | <b>Digital Conver</b> | ter (IADC) |
|-------------|-----------|-----------------------|------------|
|-------------|-----------|-----------------------|------------|

| Parameter                                                                    | Symbol                | Test Condition                                                                                     | Min              | Тур                     | Max              | Unit  |
|------------------------------------------------------------------------------|-----------------------|----------------------------------------------------------------------------------------------------|------------------|-------------------------|------------------|-------|
| Main analog supply                                                           | V <sub>AVDD</sub>     | Normal Mode                                                                                        | 1.71             | _                       | 3.8              | V     |
| Maximum Input Range <sup>1</sup>                                             | V <sub>IN_MAX</sub>   | Maximum allowable input voltage                                                                    | 0                | _                       | AVDD             | V     |
| Full-Scale Voltage                                                           | V <sub>FS</sub>       | Voltage required for Full-Scale measurement                                                        | _                | V <sub>REF</sub> / Gain | _                | V     |
| Input Measurement Range                                                      | V <sub>IN</sub>       | Differential Mode - Plus and Mi-<br>nus inputs                                                     | -V <sub>FS</sub> | -                       | +V <sub>FS</sub> | V     |
|                                                                              |                       | Single Ended Mode - One input tied to ground                                                       | 0                | -                       | $V_{FS}$         | V     |
| Input Sampling Capacitance                                                   | Cs                    | Analog Gain = 1x                                                                                   | _                | 1.8                     | _                | pF    |
|                                                                              |                       | Analog Gain = 2x                                                                                   | _                | 3.6                     | _                | pF    |
|                                                                              |                       | Analog Gain = 4x                                                                                   |                  | 7.2                     |                  | pF    |
|                                                                              |                       | Analog Gain = 0.5x                                                                                 |                  | 0.9                     | _                | pF    |
| ADC clock frequency                                                          | f <sub>CLK</sub>      | Normal Mode                                                                                        |                  | _                       | 10               | MHz   |
|                                                                              |                       | Normal mode, Gain = 2x                                                                             |                  | _                       | 5                | MHz   |
|                                                                              |                       | Normal mode, Gain = 3x or 4x                                                                       | _                | _                       | 2.5              | MHz   |
| Throughput rate                                                              | f <sub>SAMPLE</sub>   | f <sub>CLK</sub> = 10 MHz, OSR = 2                                                                 |                  | _                       | 1                | Msps  |
|                                                                              |                       | f <sub>CLK</sub> = 10 MHz, OSR = 32                                                                |                  | _                       | 76.9             | ksps  |
| Current from all supplies,<br>Continuous operation                           | I <sub>ADC_CONT</sub> | Normal Mode, 1 Msps, OSR = 2, $f_{CLK}$ = 10 MHz                                                   | —                | 290                     | 385              | μA    |
| Current in Standby mode.<br>ADC is not functional but can<br>wake up in 1us. | I <sub>STBY</sub>     | Normal Mode                                                                                        | _                | 16                      | _                | μA    |
| ADC Startup Time                                                             | t <sub>startup</sub>  | From power down state                                                                              |                  | 5                       | _                | μs    |
|                                                                              |                       | From standby state                                                                                 | _                | 1                       | _                | μs    |
| ADC Resolution <sup>2</sup>                                                  | Resolution            |                                                                                                    | _                | 12                      | _                | bits  |
| Differential Nonlinearity                                                    | DNL                   | Differential Input, OSR = 2, (No missing codes) .                                                  | -1               | +/- 0.25                | 1.5              | LSB12 |
| Integral Nonlinearity                                                        | INL                   | Normal Mode, Differential Input, OSR = 2.                                                          | -2.5             | +/- 0.65                | 2.5              | LSB12 |
| Effective number of bits <sup>3</sup>                                        | ENOB                  | Differential Input. Gain = 1x, OSR<br>= 2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V. OSR=2 | 10.5             | 11.7                    | _                | bits  |
|                                                                              |                       | Differential Input. Gain = 1x, OSR<br>= 32, f <sub>IN</sub> = 2.5 kHz, Internal VREF<br>= 1.21 V.  | —                | 13.5                    | _                | bits  |
|                                                                              |                       | Differential Input. Gain = 1x, OSR<br>= 32, f <sub>IN</sub> = 2.5 kHz, External<br>VREF = 1.25 V.  | —                | 14.3                    | —                | bits  |

| Parameter                                          | Symbol             | Test Condition                                                                              | Min  | Тур   | Max  | Unit |
|----------------------------------------------------|--------------------|---------------------------------------------------------------------------------------------|------|-------|------|------|
| Signal to Noise + Distortion<br>Ratio <sup>3</sup> | SNDR               | Differential Input. Gain=1x, OSR =<br>2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V   | 65   | 72.3  | _    | dB   |
|                                                    |                    | Differential Input. Gain=2x, OSR =<br>2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V   | —    | 72.3  | _    | dB   |
|                                                    |                    | Differential Input. Gain=4x, OSR =<br>2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V   | _    | 68.8  | _    | dB   |
|                                                    |                    | Differential Input. Gain=0.5x, OSR<br>= 2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V | _    | 72.5  | _    | dB   |
| Total Harmonic Distortion                          | THD                | Differential Input. Gain=1x, OSR =<br>2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V   | _    | -80.8 | -70  | dB   |
| Spurious-Free Dynamic<br>Range                     | SFDR               | Differential Input. Gain=1x, OSR =<br>2, f <sub>IN</sub> = 10 kHz, Internal<br>VREF=1.21V   | 72   | 86.5  | _    | dB   |
| Common Mode Rejection                              | CMRR               | Normal Mode. DC to 100 Hz                                                                   | —    | 87.0  | _    | dB   |
| Ratio                                              |                    | Normal Mode. AC high frequency                                                              | _    | 68.6  | _    | dB   |
| Power Supply Rejection Ra-                         | PSRR               | Normal mode. DC to 100 Hz                                                                   | —    | 80.4  | _    | dB   |
| tio                                                |                    | Normal mode. AC high frequency, using VREF pad.                                             | —    | 33.4  | _    | dB   |
|                                                    |                    | Normal mode. AC high frequency, using internal VBGR.                                        | —    | 65.2  | —    | dB   |
| Gain Error                                         | GE                 | GAIN=1 and 0.5, using external VREF, direct mode.                                           | -0.3 | 0.069 | 0.3  | %    |
|                                                    |                    | GAIN=2, using external VREF, di-<br>rect mode.                                              | -0.4 | 0.151 | 0.4  | %    |
|                                                    |                    | GAIN=3, using external VREF, di-<br>rect mode.                                              | -0.7 | 0.186 | 0.7  | %    |
|                                                    |                    | GAIN=4, using external VREF, di-<br>rect mode.                                              | -1.1 | 0.227 | 1.1  | %    |
|                                                    |                    | Internal VREF <sup>4</sup> , all GAIN settings                                              | -1.5 | 0.023 | 1.5  | %    |
| Offset                                             | OFFSET             | GAIN=1 and 0.5, Differential Input                                                          | -3   | 0.27  | 3    | LSB  |
|                                                    |                    | GAIN=2, Differential Input                                                                  | -4   | 0.27  | 4    | LSB  |
|                                                    |                    | GAIN=3, Differential Input                                                                  | -4   | 0.25  | 4    | LSB  |
|                                                    |                    | GAIN=4, Differential Input                                                                  | -4   | 0.29  | 4    | LSB  |
| External reference voltage range <sup>1</sup>      | V <sub>EVREF</sub> |                                                                                             | 1.0  | -     | AVDD | V    |
| Internal Reference voltage                         | VIVREF             |                                                                                             | _    | 1.21  | _    | V    |

| Parameter                           | Symbol                                         | Test Condition                                                                                                                             | Min                                               | Тур                                | Max                       | Unit      |
|-------------------------------------|------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|------------------------------------|---------------------------|-----------|
| Note:                               |                                                |                                                                                                                                            | l                                                 |                                    |                           |           |
| 1. When inputs are                  | routed to external GP                          | IO pins, the maximum pin voltag                                                                                                            | ge is limited to the lowe                         | r of the IOVD                      | D and AVDD                | supplies. |
| bits at OSR=2, 1<br>averaging has a | 3 bits at OSR = 4, 14<br>similar impact on ADC | OSR and digital averaging setti<br>bits at OSR = 8, 15 bits at OSR<br>coutput resolution. See the prod<br>NDR is specified according to th | = 16, 16 bits at OSR =<br>luct reference manual f | 32 and 17 bit<br>for additional of | s at OSR = 64<br>details. |           |
| 4. Includes error fro               | m internal VREE drift                          |                                                                                                                                            |                                                   |                                    |                           |           |

## 4.12 Temperature Sensor

| Parameter                                       | Symbol                  | Test Condition                                                                               | Min  | Тур  | Max | Unit |
|-------------------------------------------------|-------------------------|----------------------------------------------------------------------------------------------|------|------|-----|------|
| Temperature sensor range <sup>1</sup>           | T <sub>RANGE</sub>      |                                                                                              | -40  | —    | 125 | °C   |
| Temperature sensor resolu-<br>tion              | T <sub>RESOLUTION</sub> |                                                                                              | _    | 0.25 |     | °C   |
| Measurement noise (RMS)                         | T <sub>NOISE</sub>      | Single measurement                                                                           | _    | 0.6  |     | °C   |
|                                                 |                         | 16-sample average (TEMPAVG-<br>NUM = 0)                                                      | _    | 0.17 |     | °C   |
|                                                 |                         | 64-sample average (TEMPAVG-<br>NUM = 1)                                                      | _    | 0.12 |     | °C   |
| Temperature offset                              | T <sub>OFF</sub>        | Mean error of uncorrected output across full temperature range                               | _    | 3.14 |     | °C   |
| Temperature sensor accura-<br>cy <sup>2 3</sup> | T <sub>ACC</sub>        | Direct output accuracy after mean error (T <sub>OFF</sub> ) removed                          | -3   | _    | 3   | °C   |
|                                                 |                         | After linearization in software, no calibration                                              | -2   | _    | 2   | °C   |
|                                                 |                         | After linearization in software, with single-temperature calibration at $25 \ ^{\circ}C^{4}$ | -1.5 | _    | 1.5 | °C   |
| Measurement interval                            | t <sub>MEAS</sub>       |                                                                                              | _    | 250  | _   | ms   |

#### Table 4.18. Temperature Sensor

Note:

1. The sensor reports absolute die temperature in °K. All specifications are in °C to match the units of the specified product temperature range.

2. Error is measured as the deviation of the mean temperature reading from the expected die temperature. Accuracy numbers represent statistical minimum and maximum using ± 4 standard deviations of measured error.

3. The raw output of the temperature sensor is a predictable curve. It can be linearized with a polynomial function for additional accuracy.

4. Assuming calibration accuracy of ± 0.25 °C.

## 4.13 Brown Out Detectors

## 4.13.1 DVDD BOD

BOD thresholds on DVDD in EM0 and EM1 only, unless otherwise noted. Typical conditions are at  $T_A = 25$  °C. Minimum and maximum values in this table represent the worst conditions across process variation, operating supply voltage range, and operating temperature range.

#### Table 4.19. DVDD BOD

| Parameter         | Symbol                         | Test Condition                                      | Min  | Тур  | Max  | Unit |
|-------------------|--------------------------------|-----------------------------------------------------|------|------|------|------|
| BOD threshold     | V <sub>DVDD_BOD</sub>          | Supply Rising                                       | _    | 1.64 | 1.71 | V    |
|                   |                                | Supply Falling                                      | 1.62 | 1.65 | _    | V    |
| BOD response time | t <sub>DVDD_BOD_DE-</sub>      | Supply dropping at 100 mV/µs slew rate <sup>1</sup> | -    | 0.95 | _    | μs   |
| BOD hysteresis    | V <sub>DVDD_BOD_HYS</sub><br>T |                                                     | _    | 20   | _    | mV   |

## Note:

1. If the supply slew rate exceeds the specified slew rate, the BOD may trip later than expected (at a threshold below the minimum specified threshold), or the BOD may not trip at all (e.g., if the supply ramps down and then back up at a very fast rate)

## 4.13.2 LE DVDD BOD

BOD thresholds on DVDD pin for low energy modes EM2 to EM4, unless otherwise noted.

## Table 4.20. LE DVDD BOD

| Parameter         | Symbol                             | Test Condition                                    | Min | Тур | Мах  | Unit |
|-------------------|------------------------------------|---------------------------------------------------|-----|-----|------|------|
| BOD threshold     | V <sub>DVDD_LE_BOD</sub>           | Supply Falling                                    | 1.5 | _   | 1.71 | V    |
| BOD response time | t <sub>DVDD_LE_BOD_D</sub><br>ELAY | Supply dropping at 2 mV/µs slew rate <sup>1</sup> | —   | 50  | _    | μs   |
| BOD hysteresis    | V <sub>DVDD_LE_BOD_</sub><br>HYST  |                                                   | —   | 20  | _    | mV   |

Note:

1. If the supply slew rate exceeds the specified slew rate, the BOD may trip later than expected (at a threshold below the minimum specified threshold), or the BOD may not trip at all (e.g., if the supply ramps down and then back up at a very fast rate)

## 4.13.3 AVDD and IOVDD BODs

BOD thresholds for AVDD BOD and IOVDD BOD. Available in all energy modes.

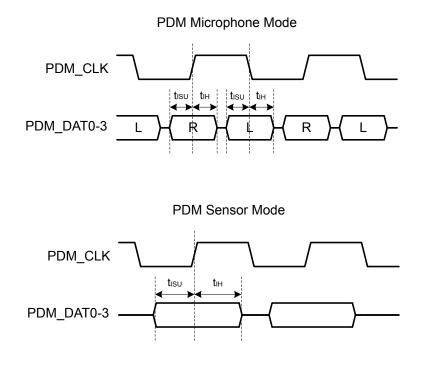
## Table 4.21. AVDD and IOVDD BODs

| Parameter         | Symbol                | Test Condition                                    | Min  | Тур | Max  | Unit |
|-------------------|-----------------------|---------------------------------------------------|------|-----|------|------|
| BOD threshold     | V <sub>BOD</sub>      | Supply falling                                    | 1.45 | —   | 1.71 | V    |
| BOD response time | tBOD_DELAY            | Supply dropping at 2 mV/µs slew rate <sup>1</sup> | _    | 50  | _    | μs   |
| BOD hysteresis    | V <sub>BOD_HYST</sub> |                                                   |      | 20  |      | mV   |

Note:

1. If the supply slew rate exceeds the specified slew rate, the BOD may trip later than expected (at a threshold below the minimum specified threshold), or the BOD may not trip at all (e.g., if the supply ramps down and then back up at a very fast rate)

#### 4.14 PDM Timing Specifications





## 4.14.1 Pulse Density Modulator (PDM), Common DBUS

Timing specifications are for all PDM signals routed to the same DBUS (DBUSAB or DBUSCD), though routing to the same GPIO port is the optimal configuration.  $C_{LOAD}$  < 20 pF. System voltage scaling = VSCALE1 or VSCALE2. All GPIO set to slew rate = 6. Data delay (PDM\_CFG1\_DLYMUXSEL) = 0.

| Parameter                | Symbol                | Test Condition  | Min  | Тур | Мах  | Unit |
|--------------------------|-----------------------|-----------------|------|-----|------|------|
| PDM_CLK frequency during | F <sub>PDM_CLK</sub>  | Microphone mode | —    | _   | 5    | MHz  |
| data transfer            |                       | Sensor mode     | _    | —   | 20   | MHz  |
| PDM_CLK duty cycle       | DC <sub>PDM_CLK</sub> |                 | 47.5 | —   | 52.5 | %    |
| PDM_CLK rise time        | t <sub>R</sub>        |                 | _    | _   | 5.5  | ns   |
| PDM_CLK fall time        | t <sub>F</sub>        |                 |      | _   | 5.5  | ns   |
| Input setup time         | t <sub>ISU</sub>      | Microphone mode | 30   | _   |      | ns   |
|                          |                       | Sensor mode     | 20   | _   | _    | ns   |
| Input hold time          | t <sub>IH</sub>       |                 | 3    | _   | _    | ns   |

| Table 4.22  | Pulse Density  | Modulator | (PDM).         | Common DBUS |
|-------------|----------------|-----------|----------------|-------------|
| 10010 4.22. | T uise Density | modulator | ( <b>D</b> m), |             |

## 4.15 USART SPI Main Timing

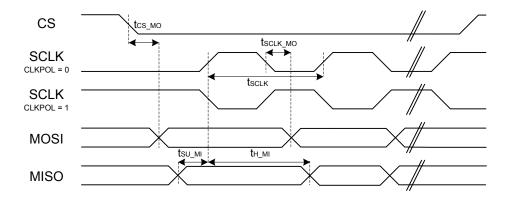


Figure 4.4. SPI Main Timing (SMSDELAY = 0)

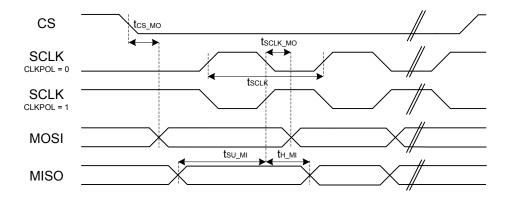


Figure 4.5. SPI Main Timing (SMSDELAY = 1)

## 4.15.1 USART SPI Main Timing, Voltage Scaling = VSCALE2

Timing specifications are for all SPI signals routed to the same DBUS (DBUSAB or DBUSCD). All GPIO set to slew rate = 6.

## Table 4.23. USART SPI Main Timing, Voltage Scaling = VSCALE2

| Parameter                      | Symbol               | Test Condition | Min                 | Тур | Max  | Unit |
|--------------------------------|----------------------|----------------|---------------------|-----|------|------|
| SCLK period <sup>1 2 3</sup>   | t <sub>SCLK</sub>    |                | 2*t <sub>PCLK</sub> | —   | _    | ns   |
| CS to MOSI <sup>1 2</sup>      | t <sub>CS_MO</sub>   |                | -22                 | _   | 22.5 | ns   |
| SCLK to MOSI <sup>1 2</sup>    | t <sub>SCLK_MO</sub> |                | -14.5               | _   | 14.5 | ns   |
| MISO setup time <sup>1 2</sup> | t <sub>SU_MI</sub>   | IOVDD = 1.62 V | 38.5                | _   | _    | ns   |
|                                |                      | IOVDD = 3.0 V  | 28.5                | _   | _    | ns   |
| MISO hold time <sup>1 2</sup>  | t <sub>H_MI</sub>    |                | -8.5                |     |      | ns   |

#### Note:

1. Applies for both CLKPHA = 0 and CLKPHA = 1.

2. Measurement done with 8 pF output loading at 10% and 90% of  $V_{\text{DD}}.$ 

3.  $t_{PCLK}$  is one period of the selected PCLK.

## 4.15.2 USART SPI Main Timing, Voltage Scaling = VSCALE1

Timing specifications are for all SPI signals routed to the same DBUS (DBUSAB or DBUSCD). All GPIO set to slew rate = 6.

## Table 4.24. USART SPI Main Timing, Voltage Scaling = VSCALE1

| Parameter                      | Symbol               | Test Condition | Min                 | Тур | Мах  | Unit |
|--------------------------------|----------------------|----------------|---------------------|-----|------|------|
| SCLK period <sup>1 2 3</sup>   | t <sub>SCLK</sub>    |                | 2*t <sub>PCLK</sub> | _   | _    | ns   |
| CS to MOSI <sup>1 2</sup>      | t <sub>cs_мо</sub>   |                | -33                 | —   | 34.5 | ns   |
| SCLK to MOSI <sup>1 2</sup>    | t <sub>SCLK_MO</sub> |                | -15                 | _   | 26   | ns   |
| MISO setup time <sup>1 2</sup> | t <sub>su_мi</sub>   | IOVDD = 1.62 V | 47                  | _   | _    | ns   |
|                                |                      | IOVDD = 3.0 V  | 39                  | _   | _    | ns   |
| MISO hold time <sup>1 2</sup>  | t <sub>H_MI</sub>    |                | -9.5                | _   |      | ns   |

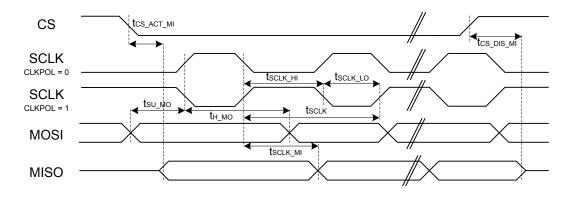
#### Note:

1. Applies for both CLKPHA = 0 and CLKPHA = 1.

2. Measurement done with 8 pF output loading at 10% and 90% of  $V_{\text{DD}}.$ 

3.  $t_{\mbox{PCLK}}$  is one period of the selected PCLK.

#### 4.16 USART SPI Secondary Timing



## Figure 4.6. SPI Secondary Timing

## 4.16.1 USART SPI Secondary Timing, Voltage Scaling = VSCALE2

Timing specifications are for all SPI signals routed to the same DBUS (DBUSAB or DBUSCD). All GPIO set to slew rate = 6.

| Parameter                         | Symbol                 | Test Condition | Min                           | Тур | Max                             | Unit |
|-----------------------------------|------------------------|----------------|-------------------------------|-----|---------------------------------|------|
| SCLK period <sup>1 2 3</sup>      | t <sub>SCLK</sub>      |                | 6*t <sub>PCLK</sub>           |     | _                               | ns   |
| SCLK high time <sup>1 2 3</sup>   | t <sub>SCLK_HI</sub>   |                | 2.5*t <sub>PCLK</sub>         | _   | _                               | ns   |
| SCLK low time <sup>1 2 3</sup>    | t <sub>SCLK_LO</sub>   |                | 2.5*t <sub>PCLK</sub>         | _   | _                               | ns   |
| CS active to MISO <sup>1 2</sup>  | t <sub>CS_ACT_MI</sub> |                | 25                            | —   | 47.5                            | ns   |
| CS disable to MISO <sup>1 2</sup> | t <sub>CS_DIS_MI</sub> |                | 19.5                          | _   | 38.5                            | ns   |
| MOSI setup time <sup>1 2</sup>    | t <sub>SU_MO</sub>     |                | 4.5                           |     | _                               | ns   |
| MOSI hold time <sup>1 2 3</sup>   | t <sub>H_MO</sub>      |                | 5                             |     | _                               | ns   |
| SCLK to MISO <sup>1 2 3</sup>     | t <sub>SCLK_MI</sub>   |                | 22 +<br>1.5*t <sub>PCLK</sub> | _   | 33.5 +<br>2.5*t <sub>PCLK</sub> | ns   |

## Note:

1. Applies for both CLKPHA = 0 and CLKPHA = 1 (figure only shows CLKPHA = 0).

2. Measurement done with 8 pF output loading at 10% and 90% of  $V_{DD}$  (figure shows 50% of  $V_{DD}$ ).

3.  $t_{PCLK}$  is one period of the selected PCLK.

#### 4.16.2 USART SPI Secondary Timing, Voltage Scaling = VSCALE1

Timing specifications are for all SPI signals routed to the same DBUS (DBUSAB or DBUSCD). All GPIO set to slew rate = 6.

## Table 4.26. USART SPI Secondary Timing, Voltage Scaling = VSCALE1

| Parameter                         | Symbol                 | Test Condition | Min                             | Тур | Max                             | Unit |
|-----------------------------------|------------------------|----------------|---------------------------------|-----|---------------------------------|------|
| SCLK period <sup>1 2 3</sup>      | t <sub>SCLK</sub>      |                | 6*t <sub>PCLK</sub>             | _   | _                               | ns   |
| SCLK high time <sup>1 2 3</sup>   | t <sub>SCLK_HI</sub>   |                | 2.5*t <sub>PCLK</sub>           | _   | _                               | ns   |
| SCLK low time <sup>1 2 3</sup>    | t <sub>SCLK_LO</sub>   |                | 2.5*t <sub>PCLK</sub>           | _   | _                               | ns   |
| CS active to MISO <sup>1 2</sup>  | t <sub>cs_аст_мі</sub> |                | 30.5                            | _   | 57.5                            | ns   |
| CS disable to MISO <sup>1 2</sup> | t <sub>CS_DIS_MI</sub> |                | 25                              | _   | 55                              | ns   |
| MOSI setup time <sup>1 2</sup>    | t <sub>su_мо</sub>     |                | 7.5                             | _   | _                               | ns   |
| MOSI hold time <sup>1 2 3</sup>   | t <sub>H_MO</sub>      |                | 8.5                             | —   | _                               | ns   |
| SCLK to MISO <sup>1 2 3</sup>     | t <sub>SCLK_MI</sub>   |                | 24.5 +<br>1.5*t <sub>PCLK</sub> | _   | 45.5 +<br>2.5*t <sub>PCLK</sub> | ns   |

## Note:

1. Applies for both CLKPHA = 0 and CLKPHA = 1 (figure only shows CLKPHA = 0).

2. Measurement done with 8 pF output loading at 10% and 90% of  $V_{DD}$  (figure shows 50% of  $V_{DD}$ ).

3.  $t_{\mbox{PCLK}}$  is one period of the selected PCLK.

#### 4.17 I2C Electrical Specifications

## 4.17.1 I2C Standard-mode (Sm)

CLHR set to 0 in the I2Cn\_CTRL register.

## Table 4.27. I2C Standard-mode (Sm)

| Parameter                                        | Symbol              | Test Condition | Min | Тур | Мах | Unit |
|--------------------------------------------------|---------------------|----------------|-----|-----|-----|------|
| SCL clock frequency <sup>1</sup>                 | f <sub>SCL</sub>    |                | 0   | _   | 100 | kHz  |
| SCL clock low time                               | t <sub>LOW</sub>    |                | 4.7 | _   | _   | μs   |
| SCL clock high time                              | t <sub>HIGH</sub>   |                | 4   | _   | _   | μs   |
| SDA set-up time                                  | t <sub>SU_DAT</sub> |                | 250 | _   | _   | ns   |
| SDA hold time                                    | t <sub>HD_DAT</sub> |                | 0   | _   | _   | ns   |
| Repeated START condition set-up time             | t <sub>SU_STA</sub> |                | 4.7 |     |     | μs   |
| Repeated START condition hold time               | t <sub>HD_STA</sub> |                | 4.0 | _   | _   | μs   |
| STOP condition set-up time                       | t <sub>SU_STO</sub> |                | 4.0 | _   |     | μs   |
| Bus free time between a STOP and START condition | t <sub>BUF</sub>    |                | 4.7 | _   | _   | μs   |

Note:

1. The maximum SCL clock frequency listed is assuming that an arbitrary clock frequency is available. The maximum attainable SCL clock frequency may be slightly less using the HFXO or HFRCO due to the limited frequencies available. The CLKDIV should be set to a value that keeps the SCL clock frequency below the max value listed.

## 4.17.2 I2C Fast-mode (Fm)

CLHR set to 1 in the I2Cn\_CTRL register.

| Table 4.28. I2C Fast-mode (Fm) |
|--------------------------------|
|--------------------------------|

| Parameter                                        | Symbol              | Test Condition | Min | Тур | Мах | Unit |
|--------------------------------------------------|---------------------|----------------|-----|-----|-----|------|
| SCL clock frequency <sup>1</sup>                 | f <sub>SCL</sub>    |                | 0   | _   | 400 | kHz  |
| SCL clock low time                               | t <sub>LOW</sub>    |                | 1.3 | _   | _   | μs   |
| SCL clock high time                              | tніgн               |                | 0.6 | _   | _   | μs   |
| SDA set-up time                                  | t <sub>SU_DAT</sub> |                | 100 | _   | _   | ns   |
| SDA hold time                                    | t <sub>HD_DAT</sub> |                | 0   | _   | _   | ns   |
| Repeated START condition set-up time             | t <sub>SU_STA</sub> |                | 0.6 | _   | _   | μs   |
| Repeated START condition hold time               | t <sub>HD_STA</sub> |                | 0.6 | _   | _   | μs   |
| STOP condition set-up time                       | t <sub>SU_STO</sub> |                | 0.6 | —   | —   | μs   |
| Bus free time between a STOP and START condition | t <sub>BUF</sub>    |                | 1.3 | _   | _   | μs   |

#### Note:

1. The maximum SCL clock frequency listed is assuming that an arbitrary clock frequency is available. The maximum attainable SCL clock frequency may be slightly less using the HFXO or HFRCO due to the limited frequencies available. The CLKDIV should be set to a value that keeps the SCL clock frequency below the max value listed.

## 4.17.3 I2C Fast-mode Plus (Fm+)

CLHR set to 1 in the I2Cn\_CTRL register.

| Parameter                                        | Symbol              | Test Condition | Min  | Тур | Max  | Unit |
|--------------------------------------------------|---------------------|----------------|------|-----|------|------|
| SCL clock frequency <sup>1</sup>                 | f <sub>SCL</sub>    |                | 0    | —   | 1000 | kHz  |
| SCL clock low time                               | t <sub>LOW</sub>    |                | 0.5  | _   | _    | μs   |
| SCL clock high time                              | t <sub>HIGH</sub>   |                | 0.26 | _   | _    | μs   |
| SDA set-up time                                  | t <sub>SU_DAT</sub> |                | 50   |     | _    | ns   |
| SDA hold time                                    | t <sub>HD_DAT</sub> |                | 0    |     | _    | ns   |
| Repeated START condition set-up time             | t <sub>SU_STA</sub> |                | 0.26 |     | _    | μs   |
| Repeated START condition hold time               | t <sub>HD_STA</sub> |                | 0.26 | _   |      | μs   |
| STOP condition set-up time                       | t <sub>su_sто</sub> |                | 0.26 |     | _    | μs   |
| Bus free time between a STOP and START condition | t <sub>BUF</sub>    |                | 0.5  | _   | _    | μs   |

## Table 4.29. I2C Fast-mode Plus (Fm+)

## Note:

1. The maximum SCL clock frequency listed is assuming that an arbitrary clock frequency is available. The maximum attainable SCL clock frequency may be slightly less using the HFXO or HFRCO due to the limited frequencies available. The CLKDIV should be set to a value that keeps the SCL clock frequency below the max value listed.

#### 4.18 Typical Performance Curves

Typical performance curves indicate typical characterized performance under the stated conditions.

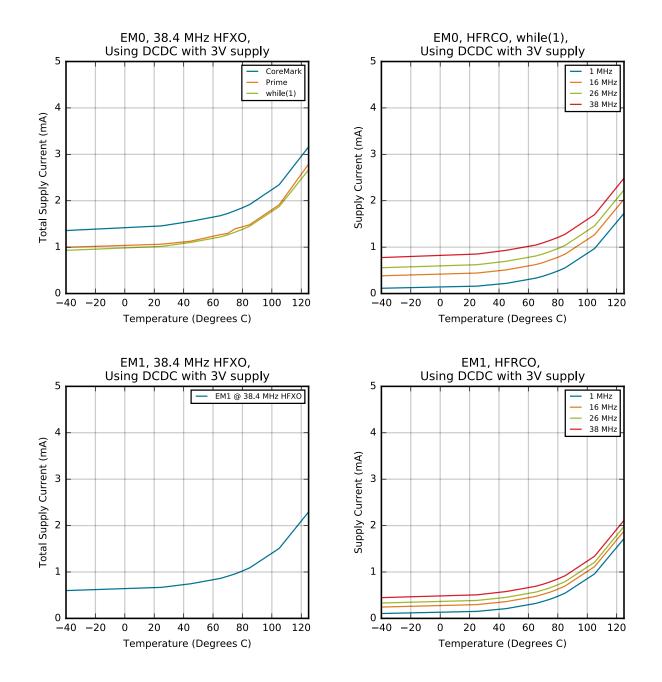


Figure 4.7. EM0 and EM1 Typical Supply Current vs. Temperature

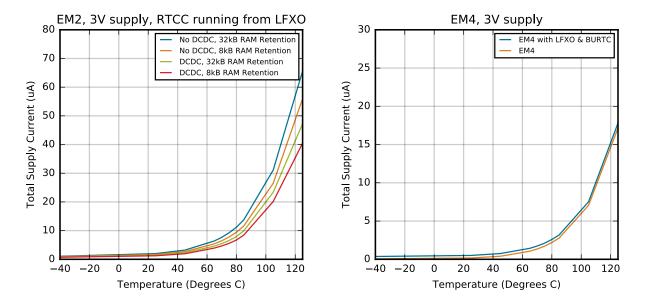


Figure 4.8. EM2 and EM4 Typical Supply Current vs. Temperature

#### 4.18.2 DC-DC Converter

Performance characterized with Samsung CIG22H2R2MNE (L<sub>DCDC</sub> = 2.2 uH) and Samsung CL10B475KQ8NQNC (C<sub>DCDC</sub> = 4.7 uF)

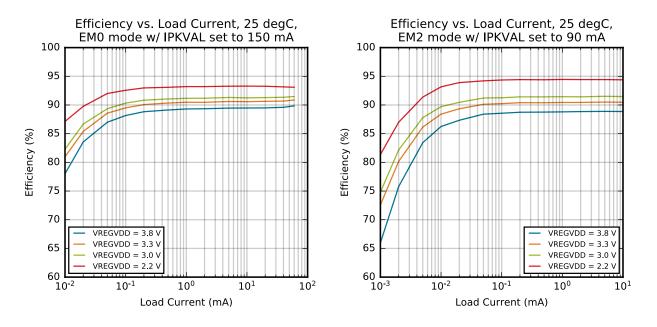


Figure 4.9. DC-DC Efficiency

## 4.18.3 IADC

Typical performance is shown using 10 MHz ADC clock for fastest sampling speed and adjusting oversampling ratio (OSR).

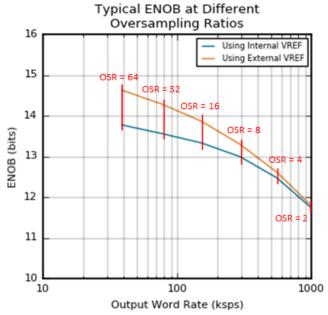


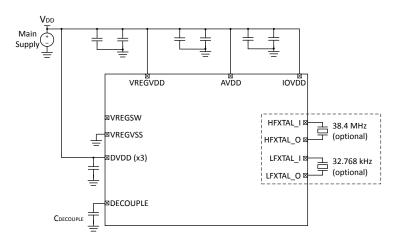
Figure 4.10. Typical ENOB vs. Oversampling Ratio

# 5. Typical Connections

## 5.1 Power

Typical power supply connections are shown in the following figures.

**Note:** AVDD and IOVDD supply connections are flexible. They may be connected in other configurations or to external supplies as long as the supply limits described in 4.1 Electrical Characteristics are met.



## Figure 5.1. EFM32PG22 Typical Application Circuit: Direct Supply Configuration without DCDC

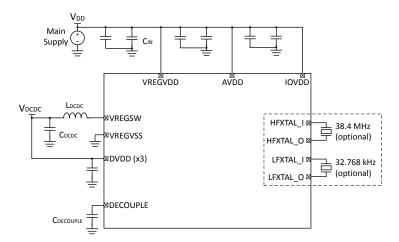
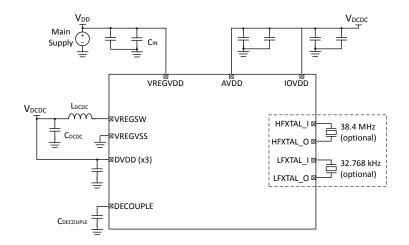


Figure 5.2. EFM32PG22 Typical Application Circuit: DCDC Configuration, AVDD and IOVDD from main supply



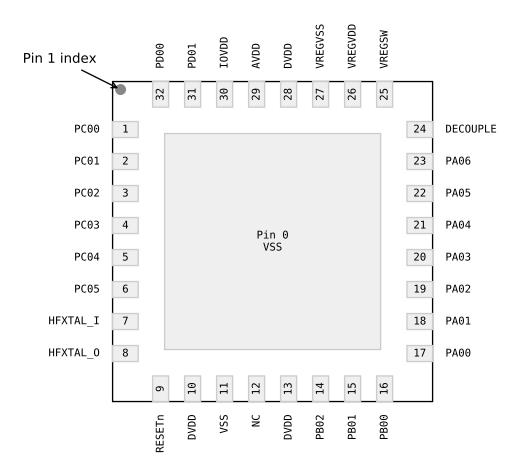
## Figure 5.3. EFM32PG22 Typical Application Circuit: DCDC Configuration, AVDD and IOVDD from DCDC output

#### 5.2 Other Connections

Other components or connections may be required to meet the system-level requirements. Application Note AN0002.2 contains detailed information on these connections. Application Notes can be accessed on the Silicon Labs website (www.silabs.com/32bit-appnotes).

## 6. Pin Definitions

## 6.1 QFN32 Device Pinout



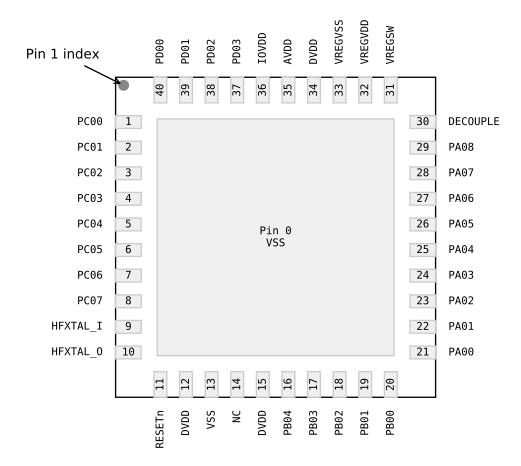
#### Figure 6.1. QFN32 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 6.3 Alternate Function Table, 6.4 Analog Peripheral Connectivity, and 6.5 Digital Peripheral Connectivity.

#### Table 6.1. QFN32 Device Pinout

| Pin Name | Pin(s) | Description                  | Pin Name | Pin(s) | Description                   |
|----------|--------|------------------------------|----------|--------|-------------------------------|
| PC00     | 1      | GPIO                         | PC01     | 2      | GPIO                          |
| PC02     | 3      | GPIO                         | PC03     | 4      | GPIO                          |
| PC04     | 5      | GPIO                         | PC05     | 6      | GPIO                          |
| HFXTAL_I | 7      | High Frequency Crystal Input | HFXTAL_O | 8      | High Frequency Crystal Output |

| Pin Name | Pin(s) | Description                                                | Pin Name | Pin(s) | Description                                                                                                 |
|----------|--------|------------------------------------------------------------|----------|--------|-------------------------------------------------------------------------------------------------------------|
| RESETn   | 9      | Reset Pin. The RESETn pin is internally pulled up to DVDD. | DVDD     | 10     | Digital power supply                                                                                        |
| VSS      | 11     | Ground                                                     | NC       | 12     | No-Connect                                                                                                  |
| DVDD     | 13     | Digital power supply                                       | PB02     | 14     | GPIO                                                                                                        |
| PB01     | 15     | GPIO                                                       | PB00     | 16     | GPIO                                                                                                        |
| PA00     | 17     | GPIO                                                       | PA01     | 18     | GPIO                                                                                                        |
| PA02     | 19     | GPIO                                                       | PA03     | 20     | GPIO                                                                                                        |
| PA04     | 21     | GPIO                                                       | PA05     | 22     | GPIO                                                                                                        |
| PA06     | 23     | GPIO                                                       | DECOUPLE | 24     | Decouple outputput for on-chip voltage regulator. An external decoupling capacitor is required at this pin. |
| VREGSW   | 25     | DCDC regulator switching node                              | VREGVDD  | 26     | DCDC regulator input supply                                                                                 |
| VREGVSS  | 27     | DCDC ground                                                | DVDD     | 28     | Digital power supply                                                                                        |
| AVDD     | 29     | Analog power supply                                        | IOVDD    | 30     | I/O power supply                                                                                            |
| PD01     | 31     | GPIO                                                       | PD00     | 32     | GPIO                                                                                                        |



## Figure 6.2. QFN40 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 6.3 Alternate Function Table, 6.4 Analog Peripheral Connectivity, and 6.5 Digital Peripheral Connectivity.

| Table 6.2. QFN40 D | Device Pinout |
|--------------------|---------------|
|--------------------|---------------|

| Pin Name | Pin(s) | Description                                                | Pin Name | Pin(s) | Description                   |
|----------|--------|------------------------------------------------------------|----------|--------|-------------------------------|
| PC00     | 1      | GPIO                                                       | PC01     | 2      | GPIO                          |
| PC02     | 3      | GPIO                                                       | PC03     | 4      | GPIO                          |
| PC04     | 5      | GPIO                                                       | PC05     | 6      | GPIO                          |
| PC06     | 7      | GPIO                                                       | PC07     | 8      | GPIO                          |
| HFXTAL_I | 9      | High Frequency Crystal Input                               | HFXTAL_O | 10     | High Frequency Crystal Output |
| RESETn   | 11     | Reset Pin. The RESETn pin is internally pulled up to DVDD. | DVDD     | 12     | Digital power supply          |

| Pin Name | Pin(s) | Description                   | Pin Name | Pin(s) | Description                                                                                                 |
|----------|--------|-------------------------------|----------|--------|-------------------------------------------------------------------------------------------------------------|
| VSS      | 13     | Ground                        | NC       | 14     | No-Connect                                                                                                  |
| DVDD     | 15     | Digital power supply          | PB04     | 16     | GPIO                                                                                                        |
| PB03     | 17     | GPIO                          | PB02     | 18     | GPIO                                                                                                        |
| PB01     | 19     | GPIO                          | PB00     | 20     | GPIO                                                                                                        |
| PA00     | 21     | GPIO                          | PA01     | 22     | GPIO                                                                                                        |
| PA02     | 23     | GPIO                          | PA03     | 24     | GPIO                                                                                                        |
| PA04     | 25     | GPIO                          | PA05     | 26     | GPIO                                                                                                        |
| PA06     | 27     | GPIO                          | PA07     | 28     | GPIO                                                                                                        |
| PA08     | 29     | GPIO                          | DECOUPLE | 30     | Decouple outputput for on-chip voltage regulator. An external decoupling capacitor is required at this pin. |
| VREGSW   | 31     | DCDC regulator switching node | VREGVDD  | 32     | DCDC regulator input supply                                                                                 |
| VREGVSS  | 33     | DCDC ground                   | DVDD     | 34     | Digital power supply                                                                                        |
| AVDD     | 35     | Analog power supply           | IOVDD    | 36     | I/O power supply                                                                                            |
| PD03     | 37     | GPIO                          | PD02     | 38     | GPIO                                                                                                        |
| PD01     | 39     | GPIO                          | PD00     | 40     | GPIO                                                                                                        |

## 6.3 Alternate Function Table

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows GPIO pins with support for dedicated functions across the different package options.

| GPIO | Alternate Functions | QFN40 Package <sup>2</sup> | QFN32 Package <sup>1</sup> |
|------|---------------------|----------------------------|----------------------------|
| PC00 | GPIO.EM4WU6         | Yes                        | Yes                        |
|      | GPIO.TRACEDATA0     | Yes                        | Yes                        |
| PA03 | GPIO.SWV            | Yes                        | Yes                        |
|      | GPIO.TDO            | Yes                        | Yes                        |
| PB01 | GPIO.EM4WU3         | Yes                        | Yes                        |
| PD00 | LFXO.LFXTAL_O       | Yes                        | Yes                        |
| PA00 | IADC0.VREFP         | Yes                        | Yes                        |
|      | LFXO.LFXTAL_I       | Yes                        | Yes                        |
| PD01 | LFXO.LF_EXTCLK      | Yes                        | Yes                        |
| PC05 | GPIO.EM4WU7         | Yes                        | Yes                        |
| PA02 | GPIO.SWDIO          | Yes                        | Yes                        |
| PD02 | GPIO.EM4WU9         | Yes                        |                            |
| PA05 | GPIO.EM4WU0         | Yes                        | Yes                        |
| PA01 | GPIO.SWCLK          | Yes                        | Yes                        |
| DAGA | GPIO.TRACECLK       | Yes                        | Yes                        |
| PA04 | GPIO.TDI            | Yes                        | Yes                        |
| PC07 | GPIO.EM4WU8         | Yes                        |                            |
| PB03 | GPIO.EM4WU4         | Yes                        |                            |

## Table 6.3. GPIO Alternate Function Table

Note:

1. QFN32 Package includes OPNs EFM32PG22C200F128IM32-C, EFM32PG22C200F256IM32-C, EFM32PG22C200F512IM32-C, and EFM32PG22C200F64IM32-C

2. QFN40 Package includes OPNs EFM32PG22C200F128IM40-C, EFM32PG22C200F256IM40-C, EFM32PG22C200F512IM40-C, and EFM32PG22C200F64IM40-C

#### 6.4 Analog Peripheral Connectivity

Many analog resources are routable and can be connected to numerous GPIO's. The table below indicates which peripherals are available on each GPIO port. When a differential connection is being used Positive inputs are restricted to the EVEN pins and Negative inputs are restricted to the ODD pins. When a single ended connection is being used positive input is available on all pins. See the device Reference Manual for more details on the ABUS and analog peripherals. Note that some functions may not be available on all device variants.

## Table 6.4. ABUS Routing Table

| Peripheral | Signal  | Р    | A   | Р    | В   | Р    | С   | Р    | D   |
|------------|---------|------|-----|------|-----|------|-----|------|-----|
|            |         | EVEN | ODD | EVEN | ODD | EVEN | ODD | EVEN | ODD |
| IADC0      | ANA_NEG | Yes  | Yes | Yes  | Yes | Yes  | Yes | Yes  | Yes |
|            | ANA_POS | Yes  | Yes | Yes  | Yes | Yes  | Yes | Yes  | Yes |

## 6.5 Digital Peripheral Connectivity

Many digital resources are routable and can be connected to numerous GPIO's. The table below indicates which peripherals are available on each GPIO port. Note that some functions may not be available on all device variants.

## Table 6.5. DBUS Routing Table

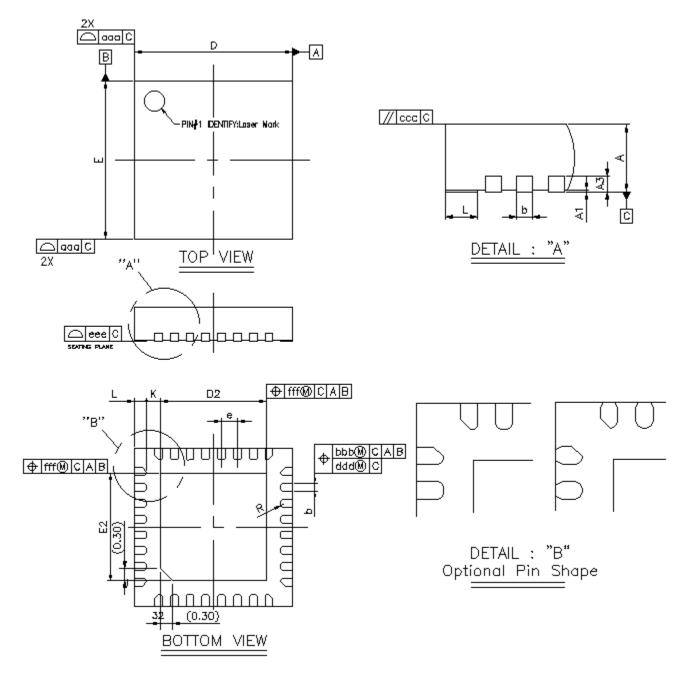
| Peripheral.Resource |           |           | PORT      |           |
|---------------------|-----------|-----------|-----------|-----------|
|                     | РА        | РВ        | PC        | PD        |
| CMU.CLKIN0          |           |           | Available | Available |
| CMU.CLKOUT0         |           |           | Available | Available |
| CMU.CLKOUT1         |           |           | Available | Available |
| CMU.CLKOUT2         | Available | Available |           |           |
| EUART0.CTS          | Available | Available | Available | Available |
| EUART0.RTS          | Available | Available | Available | Available |
| EUART0.RX           | Available | Available | Available | Available |
| EUART0.TX           | Available | Available | Available | Available |
| I2C0.SCL            | Available | Available | Available | Available |
| I2C0.SDA            | Available | Available | Available | Available |
| I2C1.SCL            |           |           | Available | Available |
| I2C1.SDA            |           |           | Available | Available |
| LETIMER0.OUT0       | Available | Available |           |           |
| LETIMER0.OUT1       | Available | Available |           |           |
| PDM.CLK             | Available | Available | Available | Available |
| PDM.DAT0            | Available | Available | Available | Available |
| PDM.DAT1            | Available | Available | Available | Available |
| PRS.ASYNCH0         | Available | Available |           |           |
| PRS.ASYNCH1         | Available | Available |           |           |
| PRS.ASYNCH2         | Available | Available |           |           |
| PRS.ASYNCH3         | Available | Available |           |           |
| PRS.ASYNCH4         | Available | Available |           |           |
| PRS.ASYNCH5         | Available | Available |           |           |
| PRS.ASYNCH6         |           |           | Available | Available |
| PRS.ASYNCH7         |           |           | Available | Available |
| PRS.ASYNCH8         |           |           | Available | Available |
| PRS.ASYNCH9         |           |           | Available | Available |
| PRS.ASYNCH10        |           |           | Available | Available |
| PRS.ASYNCH11        |           |           | Available | Available |
| PRS.SYNCH0          | Available | Available | Available | Available |
| PRS.SYNCH1          | Available | Available | Available | Available |

| Peripheral.Resource |           | PO        | RT        |           |
|---------------------|-----------|-----------|-----------|-----------|
|                     | РА        | РВ        | PC        | PD        |
| PRS.SYNCH2          | Available | Available | Available | Available |
| PRS.SYNCH3          | Available | Available | Available | Available |
| TIMER0.CC0          | Available | Available | Available | Available |
| TIMER0.CC1          | Available | Available | Available | Available |
| TIMER0.CC2          | Available | Available | Available | Available |
| TIMER0.CDTI0        | Available | Available | Available | Available |
| TIMER0.CDTI1        | Available | Available | Available | Available |
| TIMER0.CDTI2        | Available | Available | Available | Available |
| TIMER1.CC0          | Available | Available | Available | Available |
| TIMER1.CC1          | Available | Available | Available | Available |
| TIMER1.CC2          | Available | Available | Available | Available |
| TIMER1.CDTI0        | Available | Available | Available | Available |
| TIMER1.CDTI1        | Available | Available | Available | Available |
| TIMER1.CDTI2        | Available | Available | Available | Available |
| TIMER2.CC0          | Available | Available |           |           |
| TIMER2.CC1          | Available | Available |           |           |
| TIMER2.CC2          | Available | Available |           |           |
| TIMER2.CDTI0        | Available | Available |           |           |
| TIMER2.CDTI1        | Available | Available |           |           |
| TIMER2.CDTI2        | Available | Available |           |           |
| TIMER3.CC0          |           |           | Available | Available |
| TIMER3.CC1          |           |           | Available | Available |
| TIMER3.CC2          |           |           | Available | Available |
| TIMER3.CDTI0        |           |           | Available | Available |
| TIMER3.CDTI1        |           |           | Available | Available |
| TIMER3.CDTI2        |           |           | Available | Available |
| TIMER4.CC0          | Available | Available |           |           |
| TIMER4.CC1          | Available | Available |           |           |
| TIMER4.CC2          | Available | Available |           |           |
| TIMER4.CDTI0        | Available | Available |           |           |
| TIMER4.CDTI1        | Available | Available |           |           |
| TIMER4.CDTI2        | Available | Available |           |           |
| USART0.CLK          | Available | Available | Available | Available |
| USART0.CS           | Available | Available | Available | Available |
| USART0.CTS          | Available | Available | Available | Available |
| USART0.RTS          | Available | Available | Available | Available |

| Peripheral.Resource |           | PORT      |           |           |  |  |
|---------------------|-----------|-----------|-----------|-----------|--|--|
|                     | РА        | РВ        | PC        | PD        |  |  |
| USART0.RX           | Available | Available | Available | Available |  |  |
| USART0.TX           | Available | Available | Available | Available |  |  |
| USART1.CLK          | Available | Available |           |           |  |  |
| USART1.CS           | Available | Available |           |           |  |  |
| USART1.CTS          | Available | Available |           |           |  |  |
| USART1.RTS          | Available | Available |           |           |  |  |
| USART1.RX           | Available | Available |           |           |  |  |
| USART1.TX           | Available | Available |           |           |  |  |

# 7. QFN32 Package Specifications

## 7.1 QFN32 Package Dimensions





| Dimension | Min   | Тур      | Мах   |  |
|-----------|-------|----------|-------|--|
| A         | 0.80  | 0.85     | 0.90  |  |
| A1        | 0.00  | 0.02     | 0.05  |  |
| A3        |       | 0.20 REF |       |  |
| b         | 0.15  | 0.20     | 0.25  |  |
| D         | 3.90  | 4.00     | 4.10  |  |
| E         | 3.90  | 4.00     | 4.10  |  |
| D2        | 2.60  | 2.70     | 2.80  |  |
| E2        | 2.60  | 2.70     | 2.80  |  |
| е         |       | 0.40 BSC |       |  |
| L         | 0.20  | 0.30     | 0.40  |  |
| К         | 0.20  |          | _     |  |
| R         | 0.075 |          | 0.125 |  |
| ааа       |       | 0.10     |       |  |
| bbb       |       | 0.07     |       |  |
| ССС       | 0.10  |          |       |  |
| ddd       | 0.05  |          |       |  |
| eee       | 0.08  |          |       |  |
| fff       | 0.10  |          |       |  |
| Note:     |       |          |       |  |

## Table 7.1. QFN32 Package Dimensions

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.

3. This drawing conforms to the JEDEC Solid State Outline MO-220, Variation VKKD-4.

4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

## 7.2 QFN32 PCB Land Pattern

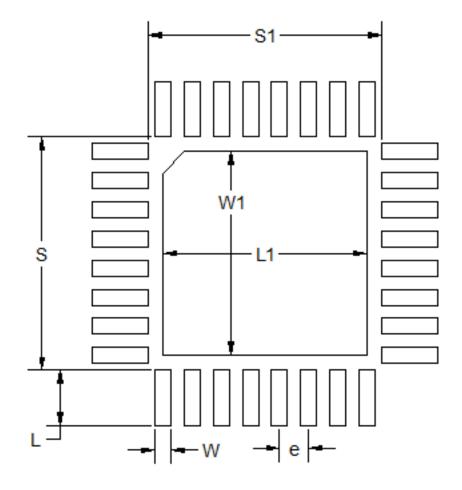


Figure 7.2. QFN32 PCB Land Pattern Drawing

### Table 7.2. QFN32 PCB Land Pattern Dimensions

| Dimension | Тур  |
|-----------|------|
| L         | 0.76 |
| W         | 0.22 |
| e         | 0.40 |
| S         | 3.21 |
| S1        | 3.21 |
| L1        | 2.80 |
| W1        | 2.80 |

## Note:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. This Land Pattern Design is based on the IPC-7351 guidelines.

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 µm minimum, all the way around the pad.

4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.

5. The stencil thickness should be 0.101 mm (4 mils).

6. The ratio of stencil aperture to land pad size can be 1:1 for all perimeter pads.

7. A 2x2 array of 1.10 mm x 1.10 mm openings on a 1.30 mm pitch can be used for the center ground pad.

8. A No-Clean, Type-3 solder paste is recommended.

9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

10. Above notes and stencil design are shared as recommendations only. A customer or user may find it necessary to use different parameters and fine tune their SMT process as required for their application and tooling.

#### 7.3 QFN32 Package Marking



## Figure 7.3. QFN32 Package Marking

The package marking consists of:

- PPPPPPP The part number designation.
- TTTTTT A trace or manufacturing code. The first letter is the device revision.
- YY The last 2 digits of the assembly year.
- WW The 2-digit workweek when the device was assembled.
- # The device revision.

# 8. QFN40 Package Specifications

## 8.1 QFN40 Package Dimensions

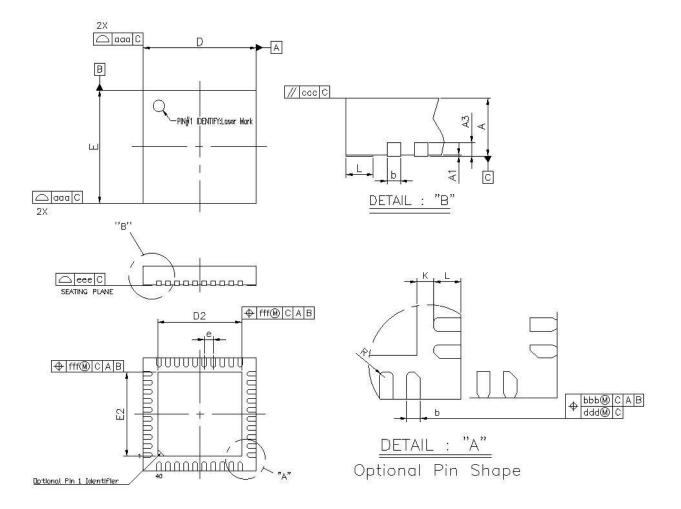


Figure 8.1. QFN40 Package Drawing

| Dimension | Min   | Тур      | Мах  |  |  |
|-----------|-------|----------|------|--|--|
| A         | 0.80  | 0.85     | 0.90 |  |  |
| A1        | 0.00  | 0.02     | 0.05 |  |  |
| A3        |       | 0.20 REF |      |  |  |
| b         | 0.15  | 0.20     | 0.25 |  |  |
| D         | 4.90  | 5.00     | 5.10 |  |  |
| E         | 4.90  | 5.00     | 5.10 |  |  |
| D2        | 3.55  | 3.70     | 3.85 |  |  |
| E2        | 3.55  | 3.70     | 3.85 |  |  |
| е         |       | 0.40 BSC |      |  |  |
| L         | 0.30  | 0.40     | 0.50 |  |  |
| К         | 0.20  | _        | _    |  |  |
| R         | 0.075 | _        | _    |  |  |
| ааа       |       | 0.10     |      |  |  |
| bbb       |       | 0.07     |      |  |  |
| ссс       | 0.10  |          |      |  |  |
| ddd       | 0.05  |          |      |  |  |
| eee       | 0.08  |          |      |  |  |
| fff       | 0.10  |          |      |  |  |
| Note:     |       |          |      |  |  |

#### Table 8.1. QFN40 Package Dimensions

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.

3. This drawing conforms to the JEDEC Solid State Outline MO-220, Variation VKKD-4.

4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

5. Package external pad (epad) may have pin one chamfer.

## 8.2 QFN40 PCB Land Pattern

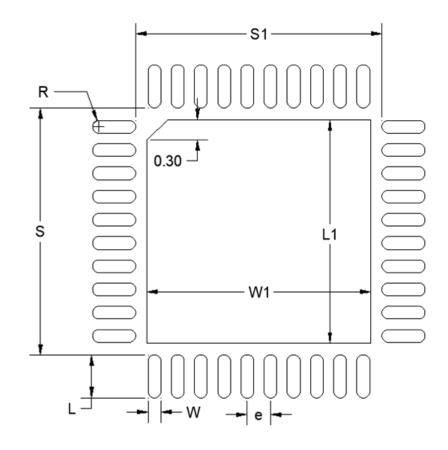


Figure 8.2. QFN40 PCB Land Pattern Drawing

| Dimension | Тур  |
|-----------|------|
| S1        | 4.25 |
| S         | 4.25 |
| L1        | 3.85 |
| W1        | 3.85 |
| e         | 0.40 |
| W         | 0.22 |
| L         | 0.74 |
| R         | 0.11 |

| Dimension                                                              | Тур                                                                |  |  |  |  |
|------------------------------------------------------------------------|--------------------------------------------------------------------|--|--|--|--|
| Note:                                                                  |                                                                    |  |  |  |  |
| 1. All dimensions shown are in millimeters (mm) unless otherwise       | noted.                                                             |  |  |  |  |
| 2. This Land Pattern Design is based on the IPC-7351 guidelines        |                                                                    |  |  |  |  |
| 3. A stainless steel, laser-cut and electro-polished stencil with tra  | pezoidal walls should be used to assure good solder paste release. |  |  |  |  |
| 4. The stencil thickness should be 0.101 mm (4 mils).                  |                                                                    |  |  |  |  |
| 5. The ratio of stencil aperture to land pad size can be 1:1 for all p | perimeter pads.                                                    |  |  |  |  |
| 6. A 3x3 array of 0.90 mm square openings on a 1.20 mm pitch c         | an be used for the center ground pad.                              |  |  |  |  |
| 7. A No-Clean, Type-3 solder paste is recommended.                     |                                                                    |  |  |  |  |
| 8. The recommended card reflow profile is per the JEDEC/IPC J-         | STD-020 specification for Small Body Components.                   |  |  |  |  |
| 9. Above notes and stencil design are shared as recommend              | ations only. A customer or user may find it necessary to use       |  |  |  |  |

different parameters and fine tune their SMT process as required for their application and tooling.

#### 8.3 QFN40 Package Marking



Figure 8.3. QFN40 Package Marking

The package marking consists of:

- PPPPPPPP The part number designation.
- TTTTTT A trace or manufacturing code. The first letter is the device revision.
- YY The last 2 digits of the assembly year.
- WW The 2-digit workweek when the device was assembled.
- # The device revision.

# 9. Revision History

## **Revision 1.2 DRAFT**

## March 2022

- Updated 8.3 QFN40 Package Marking.
- Updated Figure 7.1 QFN32 Package Drawing on page 65 with optional pin shapes to reflect multiple assembly sites.
- Added Figure 2.1 Ordering Code Key on page 4 and Table 2.1 Ordering Information on page 3.
- Updated max voltage on HFXO pins in Table 4.1 Absolute Maximum Ratings on page 17.
- Added CLKIN & DLLREFCLK max to Table 4.2 General Operating Conditions on page 18.
- Added startup time footnote in Table 4.10 High Frequency Crystal Oscillator on page 31 regarding programmable TIMEOUTSTEA-DY delay.
- Updated typical clock out current for HFRCODPLL in Table 4.12 High Frequency RC Oscillator (HFRCO) on page 33.
- Added ADC clock limitations for 2X, 3X and 4X gain in Table 4.17 Analog to Digital Converter (IADC) on page 38.
- Removed PB00 VERFN reference in Table 6.3 GPIO Alternate Function Table on page 60.
- Consolidated Table 6.3 GPIO Alternate Function Table on page 60 displaying support for dedicated functions across the different package options.
- Minor formatting and styling updates, including TOC locations and boilerplate information throughout document.

## **Revision 1.1**

## June 2021

- Updated lowest energy mode for I2C0, IADC0 and EUART0 to EM3 in 3.12 Configuration Summary.
- Added footnote for crystal load capacitance with Gain=2 test condition in 4.9.2 Low Frequency Crystal Oscillator.
- Added timing specification for RESETn low time in 4.10 GPIO Pins (3V GPIO pins).
- Added IADC 16 bit typical resolution and updated footnote in 4.11 Analog to Digital Converter (IADC).
- · Corrected clock reference to PCLK in 4.15 USART SPI Main Timing and 4.16 USART SPI Secondary Timing.
- · Corrected by removal IADC0.VREFN pinout from 6.3 Alternate Function Table; IADC0.VREFN connected internally to ground.
- Added documentation of chamfered pin 1 and oval land pattern in 8.1 QFN40 Package Dimensions.
- · Replaced select terms with inclusive lexicon.
- · Minor formatting and styling updates, including TOC locations and boilerplate information throughout document.

## **Revision 1.0**

March, 2021

- · Updated front page and feature list to reflect device offerings.
- Table 2.1 Ordering Information on page 3 updated to show all part numbers.
- 4.1 Electrical Characteristics updated throughout with full temperature range specifictions.
- Document updated throughout with additional information on higher-resolution ADC operation.
- 5.1 Power
  - Connection diagrams corrected to remove nonexistent supply pins, show crystals as optional.
  - Added text indicating IOVDD and AVDD are able to connect in other configurations.
  - Added third diagram with IOVDD and AVDD connected to DCDC output at DVDD.
- 32-pin QFN pinout information added.
- Package marking details updated.

## **Revision 0.1**

April, 2020

Initial release.

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